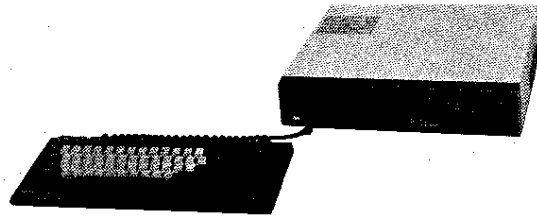


HOME PERSONAL COMPUTER **AX-500** SERVICE MANUAL



■ CONTENTS

Features	1
Specifications	1
Memory map	3
AX-500 I/O address map.....	4
Floppy disc system I/O address map.....	4
Disassembly Procedures	5
Keyboard Unit Disassembly	9
Screw Arrangement Diagram.....	10
Adjustments	11
Calendar clock adjustment.....	12
New LSI Data Table	14

008530

SINCE 1887



YAMAHA

NIPPON GAKKI CO., LTD. HAMAMATSU, JAPAN
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■ FEATURES

- Separate keyboard with 10 keys
- Equipped with 2 1-Mbyte type 3.5 inch double-sided floppy disc drivers.
- 2 cartridge slot, 1 side slot.
- Capable of outputting each picture of RGB, composite video and RF
- Main recording capacity: 256 Kbytes
- Recording capacity for video: 128 Kbytes
- YM-3814 (MSX2 system) used
 - Bit map function
 - Clock function
 - Back-up RAM (16 bytes)

■ SPECIFICATIONS

CPU to be used:	Z80A or its equivalent (LH0080A)
Clock frequency:	3.579545 MHz
Wait:	1 wait cycle inserted into M1 cycle
Interrupt:	NMI not used Interrupt from VDP and external slot is used. Normally, MSX-BASIC inter- printer uses 50Hz signal sent out from VDP as an interrupt signal. (Interrupt mode 1)
Reset:	Power ON reset or reset switch is used.

Memory

Main memory:	RAM area (with memory mapper function) 256 Kbytes 64 Kbit x 4 columns x 8 chips ROM area (including each type of application) MSX2 BASIC Ver 2.1 (INT) 32 Kbytes Exp. BASIC & Disk BASIC 32 Kbytes ARABIC BASIC 32 Kbytes SAKHR FILES 48 Kbytes ARABIC PAINTER 64 Kbytes ARABIC WP 32 Kbytes
Video RAM:	128 Kbytes

Screen Display

VDP to be used:	Video display processor V9938
Characters:	Alphanumeric characters, Arabic characters, graphic characters 256 types 8 x 8 (6 x 8 screen 0) dot Refer to Display mode for resolution, pattern size, color and number of sprites.

Calendar Function and Battery Backup Function

Calendar:	Built in YM3814 (MSX2 system) Compatible with RP5C01 (made by RICOH) on software Error: within 60 seconds/month Calendar (year, month, day) Time (hour, minute, second)
Back-up:	Calendar clock & RAM (16 bytes) built in YM3814 is backed up when main power is turned OFF.
Battery:	2 AAA type batteries are used (about 1-year service life)

I/O Interface

Separate keyboard:	13 pin DIN receptacle connector Step sculpture type (Only 10 key is step type.) Alphanumerical characters, special characters and arabic characters 48 Control and special keys 16 Cursor keys 4 Function key (10 functions available by shifting) 5 10 key 16 CODE lock and CAPS lock indicated by LED
--------------------	---

Audio cassette interface:

8 pin DIN receptacle connector
Baud rate: 1200/2400bps FSK system (changed by software)
With remote control function

Printer interface:

Unphenol 14 pin female connector
Conforming to 8 bit parallel centronics specifications TTL level

Generalized input/output (JOYSTICK etc.) 2 port:

D sub-type 9 pin male connector x 2
TTL level

A/V output

Sound output 8 octave triple chord output, special sound, noise RCA pin jack
8 octave triple chord section

47kΩ load, 0.40 ± 0.10Vrms MAX (440Hz square wave, 1ch output)
--

Special sound section

47kΩ load, 0.20 ± 0.05Vrms MAX (440Hz square wave output)

PAL composite video output

75Ω RCA pin jack

RF output UHF 36 channels

RCA pin jack

RGB output Signal corresponding to EIAJ21 pin output

8 pin DIN receptacle connector

ROM cartridge slot (SLOT A, SLOT B):

50P Female connector of MSX specifications
--

Side cartridge slot (SLOT #33):

60P Card edge connector (specially for YAMAHA)
--

Power section

Power specifications:	Primary side	100V ~ 240V (± 10%) 50/60Hz
	Secondary side	5V 3.0A +12V 0.5A -12V 0.2A
Power external output	5V ± 5%	1A (max)
	slot	300mA × 2
	I/O port	50mA × 2
	Side slot	300mA
	+12V ± 10%	100mA (max)
	-12V ± 10%	100mA (max)

General specifications

Power:	
Power consumption: Max,	21W
Operating conditions: Temperature	5 ~ 35°C
Humidity	20 ~ 80%
Dimensions (Width × height × depth):	
AX-500	395mm × 80mm × 380mm
Keyboard	417mm × 36mm × 175 mm
Curled cord	1500mm ± 50mm
Weight: Main Unit	6.7kg
Keyboard	1.8kg
AC cable:	2000mm ± 50mm

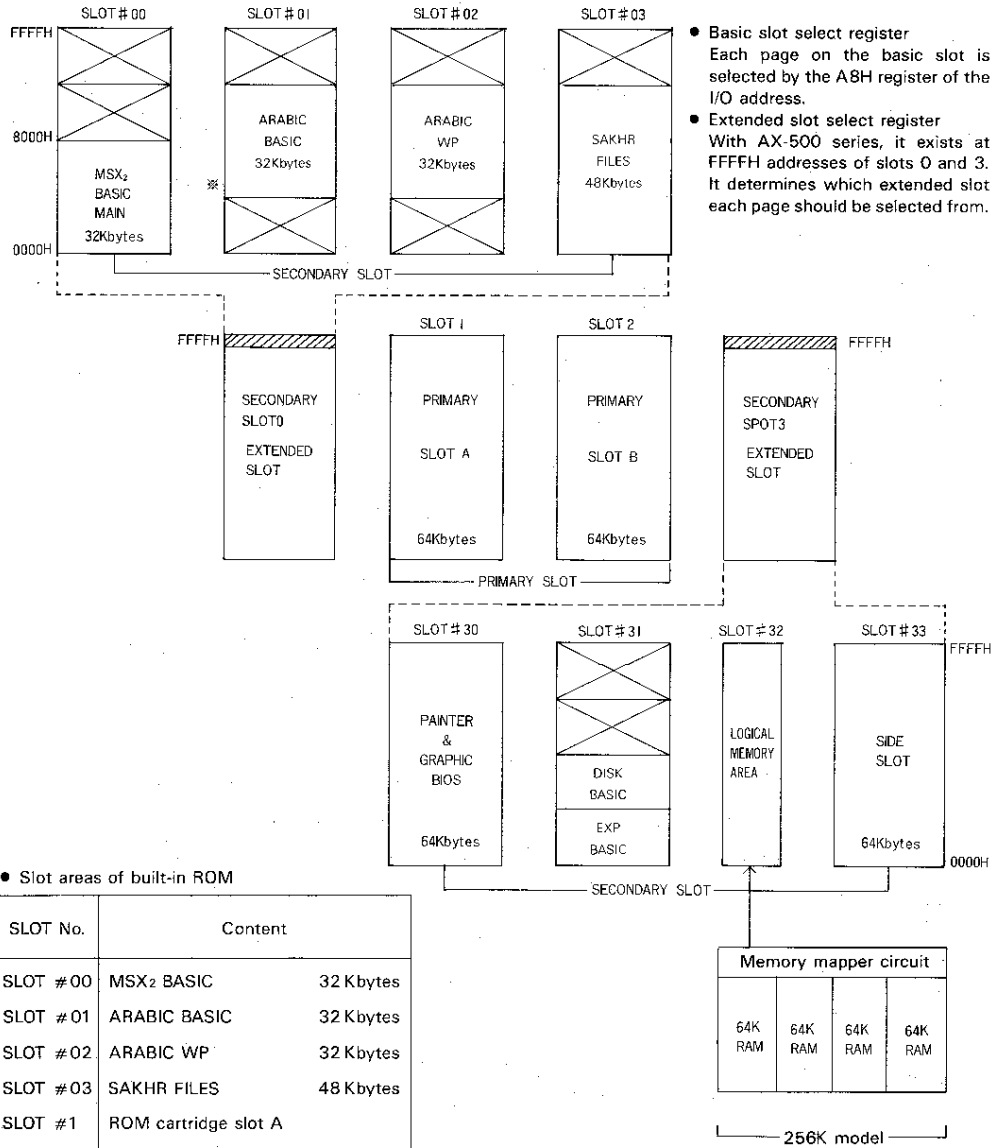
3.5 inch FDD

Number of built-in drivers:	AX-500 Model	2 units
Specifications of drivers to be used:		
Product number	JU-363-08 type	
Disc to be used	3.5 inch double-sided, double-density, double-tracks (2DD type)	
Recording capacity	1 Mbyte unformatted (both sides) 720 Kbytes formatted (both sides)	
Recording density	8717 BPI	
Track density	135 TPI	
Number of cylinders	80 cylinder	
Number of tracks	160 tracks when both sides are used.	
Access time	100ms at average	
Step rate;	6ms	
Specifications of controller:		
FDC	MB8877M (Fujitsu)	
Data separator	SED9420-CAC (SEIKO)	
	Analog filter changing type VFO	

Display Mode

	Resolution	Pattern Size	Color	Sprite Number	V-RAM Area
Text I (SCREEN 0)	256 × 192 (MAX 40 characters)	6 × 8 (256 types)	2 out of 512	No	16K
Text II (SCREEN 0)	512 × 192 (MAX 80 characters)	6 × 8 (256 types)	2 out of 512	No	16K
Multicolor (SCREEN 3)	64 × 48	4 × 4	16 out of 512	4/line out of 32	16K
G I (SCREEN 1)	256 × 192	8 × 8 (256 types)	16 out of 512	4/line out of 32	16K
G II (SCREEN 2)	256 × 192	8 × 8 (768 types)	16 out of 512	4/line out of 32	16K
G III (SCREEN 4)	256 × 192	8 × 8 (768 types)	16 out of 512	8/line out of 32	16K
G IV (SCREEN 5)	256 × 192	Bit Map	16 out of 512	8/line out of 32	32K
G V (SCREEN 6)	512 × 192	Bit Map	4 out of 512	8/line out of 32	32K
G VI (SCREEN 7)	512 × 192	Bit Map	16 out of 512	8/line out of 32	128K (2 screens)
G VII (SCREEN 8)	256 × 192	Bit Map	256 colors simultaneously	8 line out of 32	128K (2 screens)

MEMORY MAP



■ AX-500 I/O ADDRESS MAP

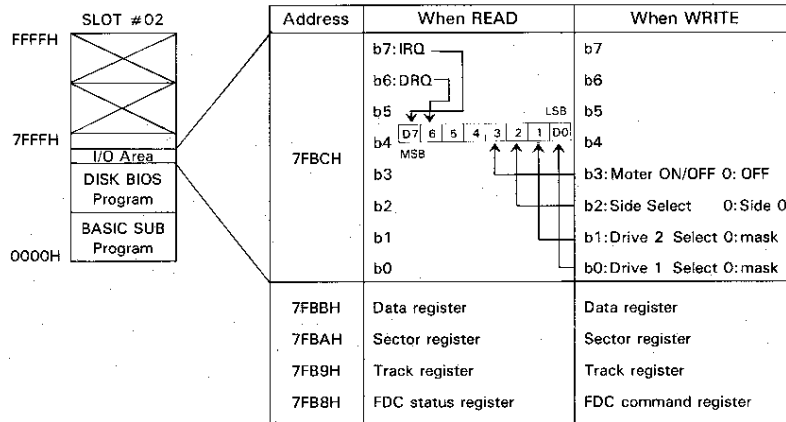
The following table shows the AX-500 I/O map.

FFH FEH FDH FCH	P/W R/W R/W R/W	Map register on p.3 Map register on p.2 Map register on p.1 Map register on p.0	Each block of M0 to M3 is assigned when the power is ON and when resetting.
B5H B4H	R/W W	Calendar clock (Built in MSX2 system)	Data (READ/WRITE) Address latch (WRITE)
ABH AAH A9H A8H	R/W R/W R R/W	Parallel port (equivalent to μ PD8255)	Mode set (bit set, reset) Keyboard strobe, cassette control PP1 sound Keyboard return read Primary slot select register
A2H A1H A0H	R W W	Sound generator, joy port, etc.	Data (READ) Data (WRITE) Internal address latch (WRITE) SSG internal register address set
9BH 9AH 99H 98H	W W R/W R/W	VDP-9938	Internal register indirect assignment (WRITE) Color palette register access (WRITE) Command access to VDP/status read Data to V-RAM READ/WRITE
91H 90H	W R/W	Printer port	Data output (printer) Busy (READ) bit 1 Strobe (WRITE) bit 0
47H 46H	R/W W		Bit pattern (WRITE)/color code (READ) FG, BG color code (WRITE)
42H 41H	R/W W		Back-up RAM (data) READ/WRITE Back-up RAM address latch
40H	R/W		Device ID number register

■ FLOPPY DISK SYSTEM I/O ADDRESS MAP

The I/O address for the floppy disk system is assigned to a part of the memory area of application software by using the memory mapped I/O system.

Floppy disk system I/O address map



7FB8H to 7FBBH are internal registers of FDC (MB8877).

■ DISASSEMBLY PROCEDURES

Top Cover Removal

- Unscrew 4 screws on both sides.
- Unscrew the screw at the upper center of the rear panel.
- Remove the top cover by lifting it up while using care for the groove of the side slot guide.

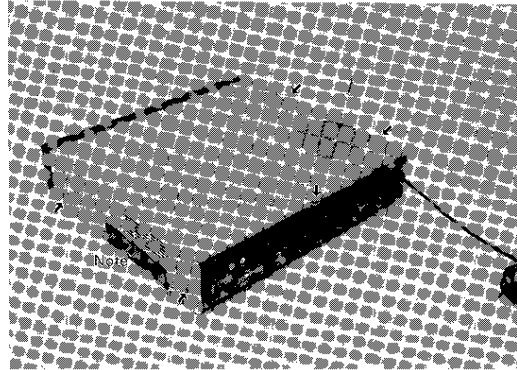


Photo 1

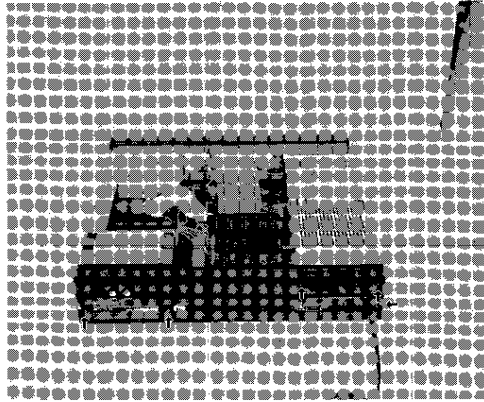


Photo 2

Rear Panel Removal

- Unscrew 5 screws fixing the rear panel.
- Remove the rear panel by opening it from the lower side while sliding it upward a little.

AC Inlet Ass'y Removal

- Unscrew 2 screws fixing the AC inlet ass'y. (Photo. 3-A)
 - Disconnect 2 power lines from the AC inlet ass'y. Connector for front panel ass'y (Photo. 3-C) Connector for CPU main circuit board (CN304) (Photo. 3-D)
 - Remove the AC inlet ass'y by lifting it up.
- Note) The power unit (power circuit board) is installed in the AC inlet ass'y.

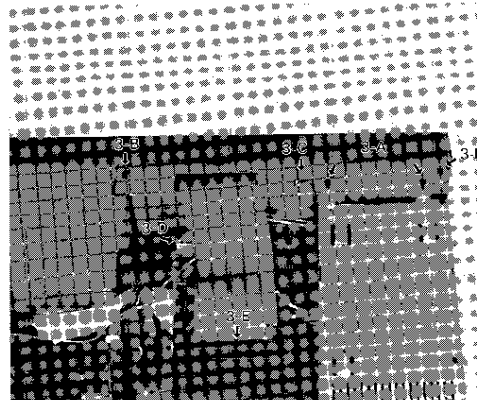


Photo 3

Front Panel Ass'y Removal

- Unscrew 2 screws in the upper part of the front panel ass'y (Photo. 3-B)
 - Disconnect the flat cable (CN308) to the CPU main circuit board. (Photo. 3-E)
 - Remove 4 plastic stoppers of the front panel ass'y from the bottom of the main unit by pushing them with a screwdriver. (Photo. 4)
- * With the YIS805/128 model, if a floppy disk driver

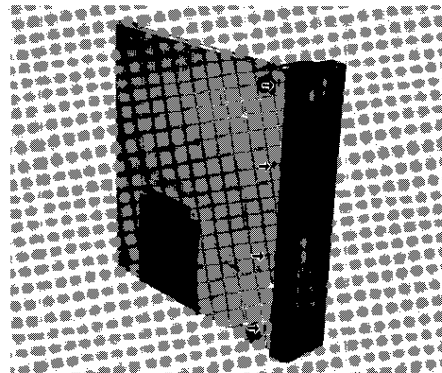


Photo 4

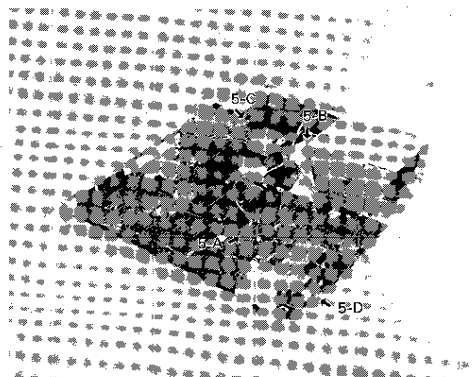


Photo 5

CPU Main Circuit Board Removal

- Pull off the battery cable ass'y (CN309). (Photo. 5-A)
 - Pull off the power line to the floppy disk driver and 34P flat cable from the connector on the floppy disk driver. (Photo. 5-B)
 - Disconnect the connector of the video circuit board. (Photo. 5-C)
 - Unscrew 6 screws fixing the CPU main circuit board and 2 screws of the side slot ground. (Refer to the screw list.)
- Remove 2 PC supports (Black) in the center of the CPU main circuit board.
- Remove the keyboard connector from the bottom chassis by loosening 2 screws. (Photo. 5-D)

Video Encoder Circuit Board Removal

- Pull off the harness (CN201) from the CPU main circuit board. (Photo. 6-A)
- Unscrew 4 screws.
- Remove the video encoder circuit board by pulling it rearward.

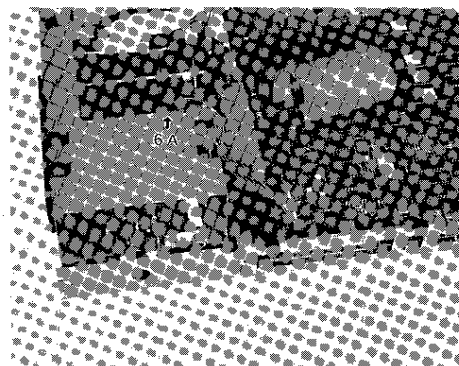


Photo 6

FDD Floppy Disk Driver Removal

- Unscrew 2 screws fixing the FDD shielding ass'y.
- Pull out the connector to the FDD (with 34 pin flat cable and power cable).
- Unscrew 4 screws fixing the video encoder circuit board. (Photo. 6)
- Remove the FDD shielding ass'y with 2 floppy disk drivers mounted as they are.

Note: As the FDD shielding ass'y is held by catches of the main body chassis, slide it forward for its removal.

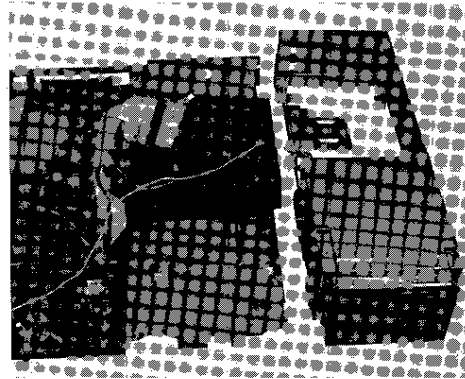


Photo 7

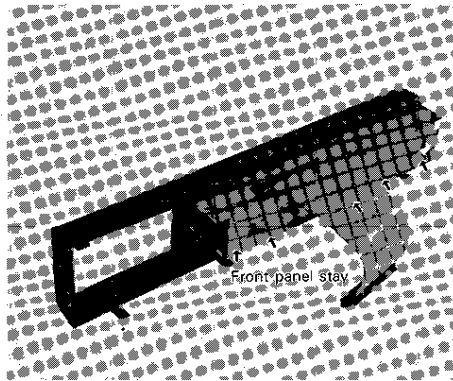


Photo 8

Front Panel Ass'y Disassembly

- Unscrew 4 screws (3 × 16) fixing the front panel stay.
- Remove the stay by sliding it rearward gradually while using care for the 60 pin flat cable.

- Pull off the connector of the micro switch ass'y from the slot circuit board. (Photo. 9-A)
- Unscrew 2 screws (3 × 8) fixing the cartridge case and remove the cartridge case ass'y from the front panel. (Photo. 9-B)

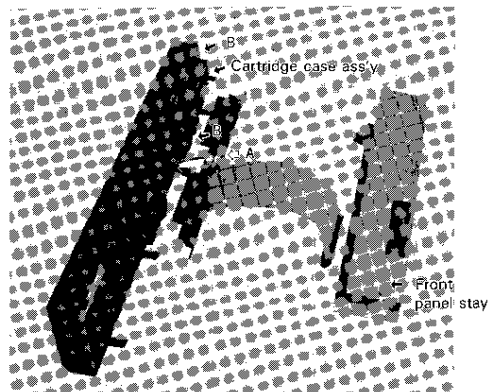


Photo 9

* Note that a fine ground wire is connected on the back of the 60 pin flat cable. Be careful not to move the cable with force in removal, for it may break the fine ground wire.

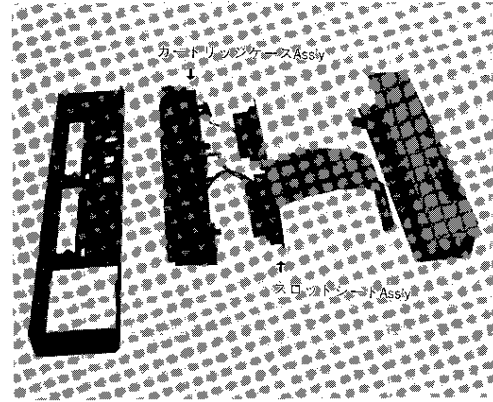


Photo 10

■ KEYBOARD UNIT DISASSEMBLY

Keyboard Circuit Board Removal

- (1) Unsolder A and B in Fig. 1.
- (2) Straighten the catches numbered from 1 to 6 in the figure.
- (3) Remove the flexible circuit board from the connectors C and D as shown in Fig. 2.
- (4) Remove the keyboard circuit board gradually.

Keyboard Contact Point Removal

- (1) Unscrew 13 special screws shown in Fig. 1, and the contact point of the keyboard can be removed.

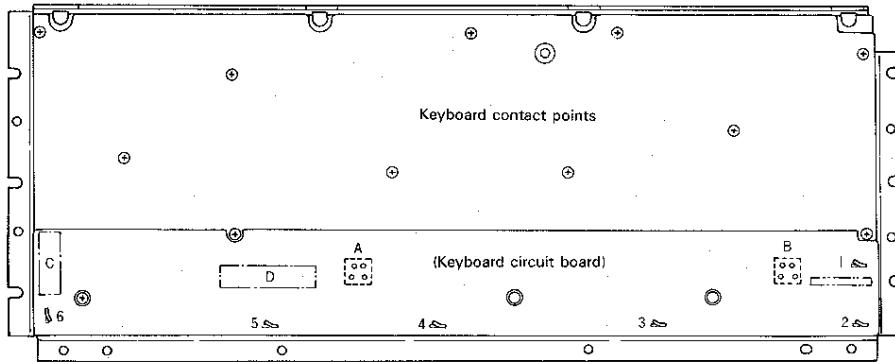


Fig. 1

Fig. 1

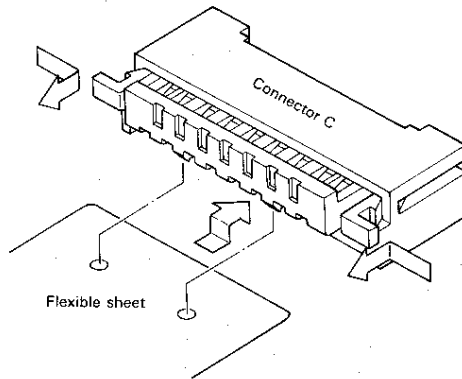
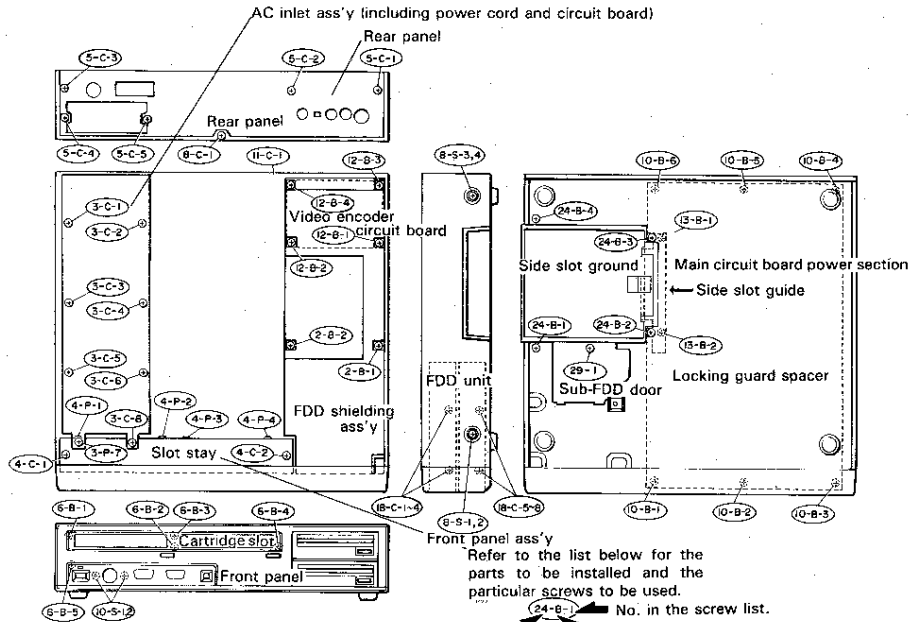


Fig. 2

Note: Insert the flexible sheet while fitting the catches of the connector into the holes in the flexible sheet.

■ SCREW ARRANGEMENT DIAGRAM



Select proper screws based on the diagram and these marks.

Type of screw
 B : B tight (binding tapping screw)
 C : C tight (binding machine screw)
 P : P tight (binding tapping screw)
 S : S tight (binding tapping screw)

Screw List

No.	Part to be installed	Type of screw and quantity					Total (pcs.)
		+ binding B tight 3 x 8	+ binding C tight 3 x 6	+ binding P tight 3 x 14	Cup 5 tight	Coin slotted pan head	
24	Side slot guide (to bottom)	4					4
10	Main circuit board (to bottom)	6			2 (to K8 connector)		8
13	Side slot ground	2					2
2	FDD shielding ass'y (to bottom)	2					2
12	Video circuit board (to FDD shielding ass'y)	4					4
18	FDD unit (for 2 units)		8				8
6	Front panel (cartridge slot LED)	5					5
4	Slot stay and circuit board (to front panel)		2 (to bottom)	4			6
3	Power supply unit (to shielding)		8				8
5	Rear panel		5				5
8	Top cover		1 (to rear panel)		4		5
29	Sub-FDD door	1				(1)	1
	Total (pcs.)	24	24	4	6	(1)	58

■ ADJUSTMENTS

< Voltage Adjustment >

Item	For
Conditions	Connect power circuit to CPU board. No load applied to each slot (such as game cartridge) of CPU board. No peripheral equipments (such as printer and joy stick) should not be connected.
Voltage adjustment	+5.10V ± 5% Connector CN304 (2 pin) and GND
Voltage Confirmation	-12V Connector CN304 (4 pin) and GND: -12V ± 10.0% +12V Connector CN304 (1 pin) and GND: +12V ± 10.0%

- With each unit connected, adjust VR101 in the power supply unit so that the output voltage is obtained at the voltage input terminal of the CPU circuit board CN304 as described in the above table.

< Adjustment and Confirmation of Calendar Clock and Back-up Circuit >

Calendar clock adjustment

Write "0011B" into the test register of the calendar clock, set to TEST 3 mode and adjust TC301 on CPU circuit board so that the frequency of the output signal at ALARM terminal of YM3814 (S-1985) 87 pin satisfies the following specification. (Refer to p.12 for the calendar clock adjustment.)

Item	For
Calendar clock	YM3814 (S-1985) 87 pin 8.192 [KHz] ± 0.2 [Hz]

Confirmation of battery back-up operation

Using BASIC command or MSX-DOS command, put time/ year, month and day in memory.

Turn OFF the power once and ON again, then check to make sure that the time/year, month and day is maintained correctly.

Confirmation of battery back-up circuit terminal voltage

Check to make sure that the voltage at 86 pin BVSS terminal of YM3814 (S-1985) satisfies specifications given below.

Power	Value
When ON	0~0.7V

Power	Value
When OFF	-2.2V or less

< **Adjustment and confirmation of picture circuit** >

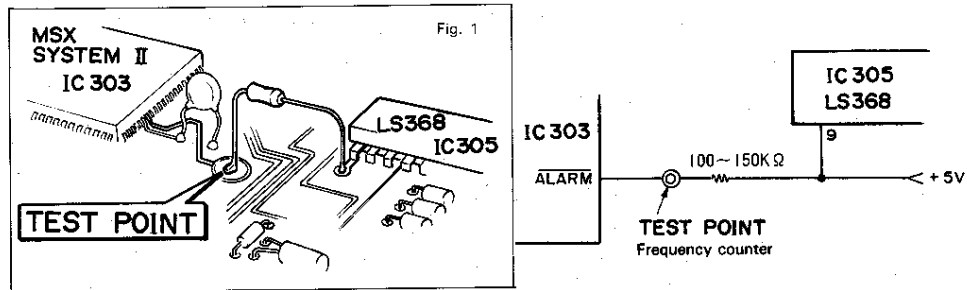
Check or adjust for the following at the connecting point A/V connector (CN312) on CPU circuit board.

Pin No.	Name	Item
1	AUDIO	Confirm sound output.
2	VIDEO	Connect video unit and confirm composite video signal.
3	GND	
4	SC	Adjust with TC302 for; CPU CLOCK TTL level $f = 3.57945 \text{ [MHz]} \pm 500 \text{ [Hz]}$.
5	NC	NON CONNECT
6	SYNC	Negative polarity, period signal output TTL level
7	GND	
8	B	Confirm that voltage is between 0.85V and 1.10V when screen display is white.
9	G	
10	R	

■ **CALENDAR CLOCK ADJUSTMENT**

1. Preparation for adjustment

Connect a 100K to 150K pull-up resistor between the TEST point and +5V (IC305, 9 pin: LS368) of the CPU circuit board as shown in Fig. 1.



With the CPU circuit board in operating state, prepare BASIC programs as follows.

```

10 OUT & HB4, & HE
20 OUT & HB5, & H3
30 END
    
```

2. Measurement and adjustment

With a frequency counter connected to the TEST point, run the program and adjust TC301 (variable trimmer) so that $f = 8.192\text{KHz} \pm 0.2\text{Hz}$ is satisfied.

● SED9420COB (DATA SEPARATER)

Pin No.	Pin Name	Function
1	OSC1	Inverting amplifier gate input in crystal oscillation circuit
2	OSC2	Inverting amplifier drain output in crystal oscillation circuit
3	CLK1	Clock input for FDC Standard floppy (8 inch): 8MHz Mini floppy (5 inch): 4MHz
4	TEST2	TEST terminal (input terminal with pull-up resistor)
7	RD DATA	Input terminal (with pull-up resistor) of read data signal from floppy disk driver unit (FDD)
8	WINDOW	Output terminal of data window signal for separating DATA signal into clock pulse and data pulse.
9	DATA	Output terminal for data signal produced from RD data signal. It is separated into data pulse and clock pulse by window signal which is read to FDC.
10	MFM/FM	Terminal for changing recording system between single density and double density (with pull-up resistor) · Double density (MFM recording): High level · Single density (FM recording): Low level
11	MIN/STD	Terminal for changing floppy disk type between mini type (5 inch) and standard type (8 inch) · 5 inch floppy disk: High level · 8 inch floppy disk: Low level
12	Vss1	Ground terminal (digital system)
13	Vss2	Ground terminal (analog system)
14	CONTROL	For control of VCO (Voltage Controlled Oscillator) Input terminal for voltage (output voltage of loop filter)
15	OFFSET	Input terminal of offset voltage for correcting oscillation center frequency of VCO. Offset voltage can be also generated automatically by externally attaching capacity.
17	LPF	Connecting terminal of loop filter (output terminal of charge pump)
18	TEST1	Test terminal (not connected usually)
19	WCLK	Write clock for FDC · STD (8 inch)/MFM : T = 1 μ sec · STD/FM : T = 2 μ sec · MIN/MFM : T = 2 μ sec · MIN/FM : T = 4 μ sec
20	CR	C-R externally attached terminal for timer circuit
21	CLK2	MB8877 system, clock output terminal for FDC · 8 inch floppy : 2MHz · 5 inch floppy : 1MHz
22	TRIG IN	Trigger input terminal for timer circuit (with pull-up resistor)
23	TM OUT	Timer circuit output terminal
24	VDD	+5V power voltage terminal

Note) The input terminal with pull-up resistor is pulled up by a resistor whose standard value is 100k Ω . As noise tends to affect easily when used open, it is recommended to connect directly to VDD if the input terminal is used High level.

■ NEW LSI DATA TABLE

● MB-8877 (FDC)

Pin No.	Pin Name	I/O	Function
1			
2	\overline{WE}	I	Write request signal to internal register
3	\overline{CS}	I	FDC chip select signal
4	\overline{RE}	I	Read request signal to internal register
5	A0	I	Address line to select internal register
6	A1	I	Address line to select internal register
7	DAL0	I/O	Data line
8	DAL1	I/O	
9	DAL2	I/O	
10	DAL3	I/O	
11	DAL4	I/O	
12	DAL5	I/O	
13	DAL6	I/O	
14	DAL7	I/O	
15	STEP	O	Head movement pulse to FDD
16	DIRC	O	Head movement direction select signal to FDD
17	EARLY	O	Shift write data to the faster side
18	LATE	O	Shift write data to the later side
19	\overline{MR}	I	FDC chip reset signal
20	Vss	—	Ground
21	V _{DD}	—	+ 5V power supply
22	\overline{TEST}		Pulled up
23	HLT		Pulled up
24	CLK	I	Clock pulse input
25	RG		Read gate
26	RCLK	I	Read data window pulse
27	$\overline{RAW READ}$	I	The raw data directly obtained from the disk
28	HLD	O	Press the head on the diskette
29	TG43	O	Head occurata larger track than 44
30	WG	O	Data is being written on the disk
31	WD	O	Write data for the diskette
32	READY	—	Pulled up
33	WF/VF	—	Write data error generated in diskette
34	$\overline{TR00}$	I	Head occure on track 00
35	IP	I	Index hole detection
36	\overline{WPRT}	I	Diskette write disable
37	\overline{DDEN}	I	Access a double density diskette
38	DRQ	O	Data request IRQ signal
39	IRQ	O	IRQ signal
40	V _{BB}	—	+ 12V power supply

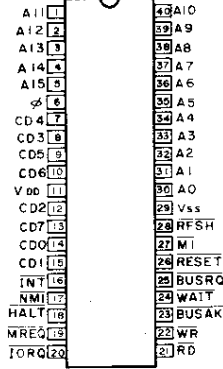
● YM-3814 (MSX2-SYSTEM)

Pin No.	Pin Name	I/O	Function
1	AVss	—	Analogue ground
2	PPISND	O	Software controlled sound signal
3	KBDIP	O	Keyboard bus buffer direction signal
4	MA17	O	Address line for memory mapper circuit (256KB)
5	MA16	O	Address line for memory mapper circuit (128KB)
6	MA15	O	Address line for memory mapper circuit (64KB)
7	MA14	O	Address line for memory mapper circuit (32KB)
8	$\overline{\text{VDPCW}}$	O	VDP write enable signal & chip select
9	$\overline{\text{VDP CR}}$	O	VDP read enable signal & chip select
10	AB15	I	Address line from Z80A CPU for page select etc.
11	AB14	I	Address line from Z80A CPU for page select etc.
12	AB7	I	Address line from Z80A CPU for I/O area select etc.
13	AB6	I	
14	AB5	I	
15	AB4	I	
16	AB3	I	
17	AB2	I	
18	AB1	I	
19	AB0	I	
20	DB7	I/O	Data Bus for Z80A CPU
21	DB6	I/O	
22	DB5	I/O	
23	DB4	I/O	
24	DB3	I/O	
25	DB2	I/O	
26	DB1	I/O	
27	DB0	I/O	
28	$\overline{\text{RSEL}}$	I	Secondary slot register select signal input
29	$\overline{\text{KANJI}}$	O	KANJI ROM Select signal
30	ϕIN	I	CPU clock signal 3.579545MHz
31	DVss	—	Digital ground
32	$\overline{\text{MT}}$	I	Instruction fetch signal from Z80A CPU
33	$\overline{\text{RFSH}}$	I	Refresh signal from Z80A CPU
34	$\overline{\text{MREQ}}$	I	Memory request signal from Z80A CPU
35	$\overline{\text{IORQ}}$	I	I/O port request signal from Z80A CPU
36	$\overline{\text{RD}}$	I	Read request signal from Z80A CPU
37	$\overline{\text{WR}}$	I	Write request signal from Z80A CPU
38	$\overline{\text{WAIT}}$	O	Wait timing signal to Z80A CPU
39	$\overline{\text{RAS}}$	O	RAS signal to D-RAM
40	VDD	—	+5V power supply
41	MPX	O	Multiplex signal for D-RAM address bus
42	$\overline{\text{CAS}}$	O	CAS signal to D-RAM
43	$\overline{\text{WE}}$	O	WRITE enable signal for D-RAM
44	$\overline{\text{CS1}}$	O	ROM chip select signal (4000H ~ 7FFFH)
45	$\overline{\text{CS2}}$	O	ROM chip select signal (8000H ~ BFFFH)
46	$\overline{\text{CS12}}$	O	ROM chip select signal (4000H ~ BFFFH)
47	$\overline{\text{SLT00}}$	O	Secondary SLOT 00 select signal
48	$\overline{\text{SLT01}}$	O	Secondary SLOT 01 select signal
49	$\overline{\text{SLT02}}$	O	Secondary SLOT 02 select signal
50	$\overline{\text{SLT03}}$	O	Secondary SLOT 03 select signal

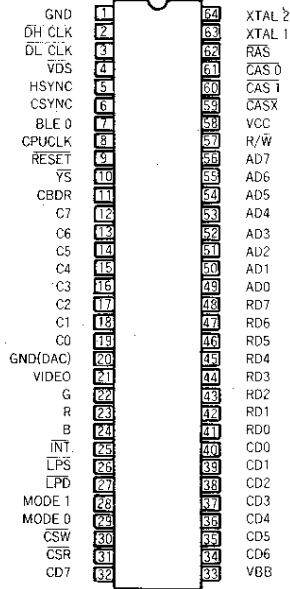
Pin No.	Pin Name	I/O	Function
51	SLT1	O	Primary SLOT1 select signal
52	SLT2	O	Primary SLOT2 select signal
53	SLT30	O	Secondary SLOT30 select signal
54	SLT31	O	Secondary SLOT31 select signal
55	SLT32	O	Secondary SLOT32 select signal
56	SLT33	O	Secondary SLOT33 select signal
57	FWD1	I	Joystick poart 1 signal
58	BACK1	I	
59	LEFT1	I	
60	RIGHT1	I	
61	TRGA1	I/O	
62	TRGB1	I/O	
63	STB1	O	
64	FWD2	I	Joystick poart 2 signal
65	BACK2	I	
66	LEFT2	I	
67	RIGHT2	I	
68	TRGA2	I/O	
69	TRGB2	I/O	
70	STB2	O	
71	CAPS	O	CAPS LED ON/OFF signal
72	KANA	O	KANA LED ON/OFF signal
73	X0	I	Keyboard return signal
74	X1	I	
75	X2	I	
76	X3	I	
77	X4	I	
78	X5	I	
79	X6	I	
80	X7	I	
81	YA	O	Keyboard scanning signal
82	YB	O	
83	YC	O	
84	YD	O	
85	RESET	I	Reset control signal ("H" enable)
86	BVss	-	Buck up battery for timer (& for memory)
87	ALM	O	Alarm signal from timer
88	Xout	O	Timer clock signal to quarty circuit
89	Xin	I	Timer clock signal from quarty circuit
90	VDD	-	+5V power supply
91	PDIR	O	Printer data bus direction control signal
92	PRD	O	Printer port read request signal
93	PWR	O	Printer port write request signal
94	PSTB	O	Printer STROBE signal
95	PBUSY	I	Printer BUSY signal
96	CMI	I	CMT read signal (data signal)
97	CMO	O	CMT write signal (write data)
98	REM	O	CMT motor ON/OFF control signal
99	SSGSNDL	O	SSG Left sound signal
100	SSGSNDR	O	SSG Right sound signal

■ LSI Pin Configuration

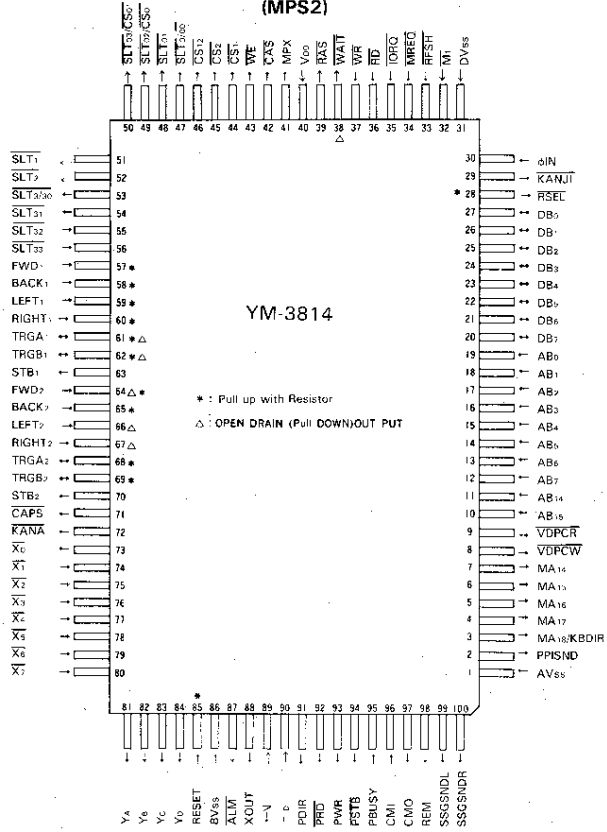
Z-80A
(CPU)



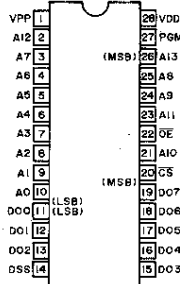
V9938
(VDP)



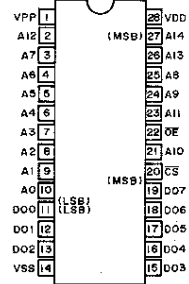
S1985
(MPS2)



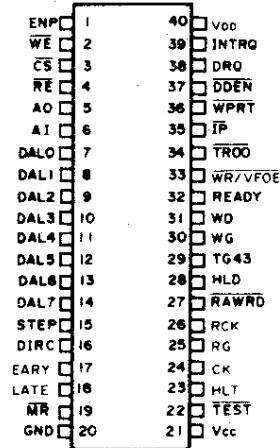
27128
(ROM-128K bits)



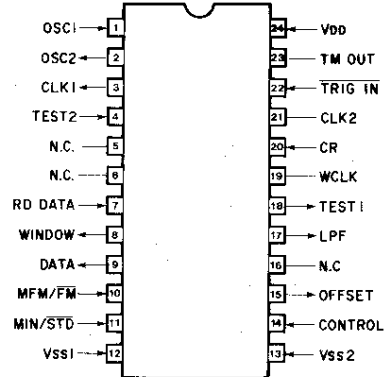
27256
(ROM-256K bits)



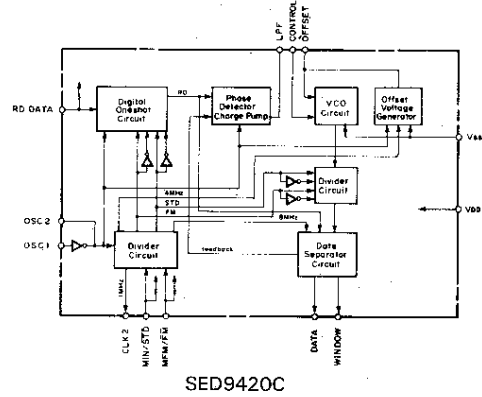
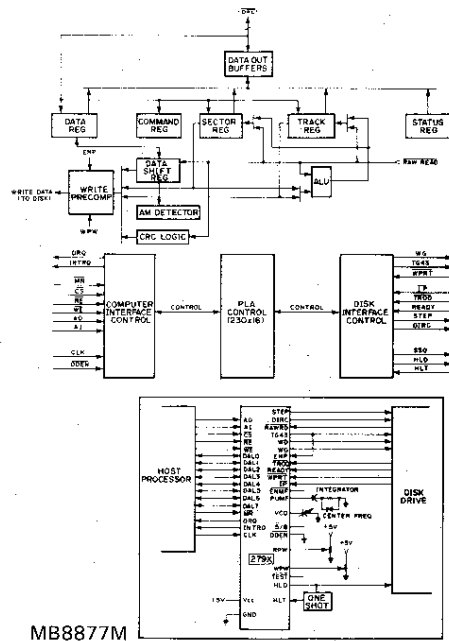
MB8877M
(FDC)



SED9420C
(DATA SEPARATOR)



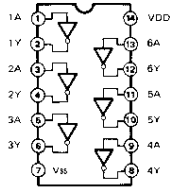
BLOCK DIAGRAM



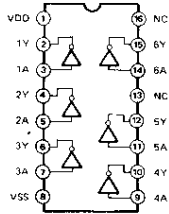
MB8877M

SED9420C

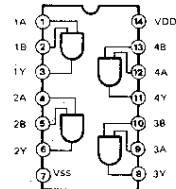
● **7404**
Hex Inverter



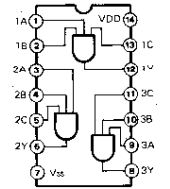
● **7406**



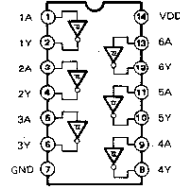
● **7408**
Quad 2 Input AND



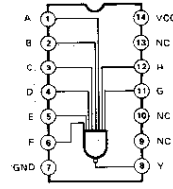
● **7411**
Triple 3 Input AND



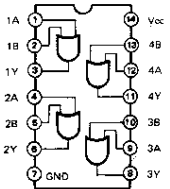
● **7414**
Hex Inverter



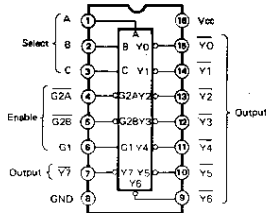
● **7430**
8 Input NAND



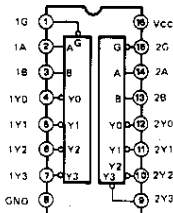
● **7432**
Quad 2 Input OR



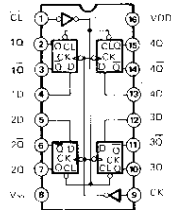
● **74138**
3 to 8 Demultiplexer



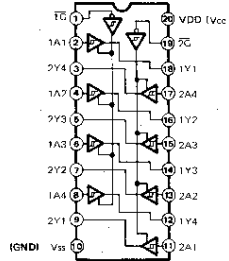
● **74139**
Dual 2 to 4 Demultiplexer



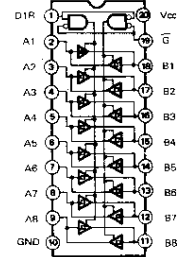
● **74175**
Quad D-Type Flip-Flop



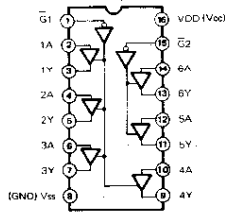
● **74244**
Octal 3-State Bus Buffer



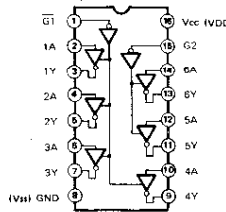
● **74245**
Octal 3-State Bus Transceiver



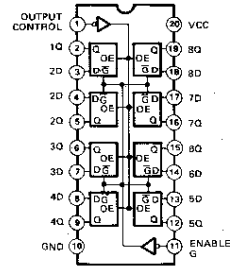
● **74367**
Hex 3-State Bus Buffer



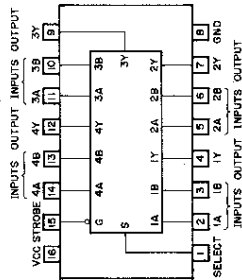
● **74368**
Hex 3-State Bus Inverter



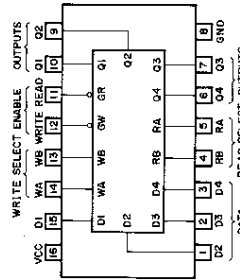
● **74373**
Octal 3-State D-Type Latch



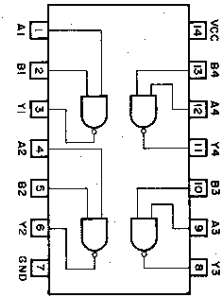
● **HC157**
Quad 2 to 1 Multiplexer



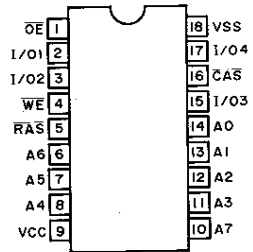
● **74LS670**



● **74LS00**



●MB81464
(D-RAM 64K x 4 bits)

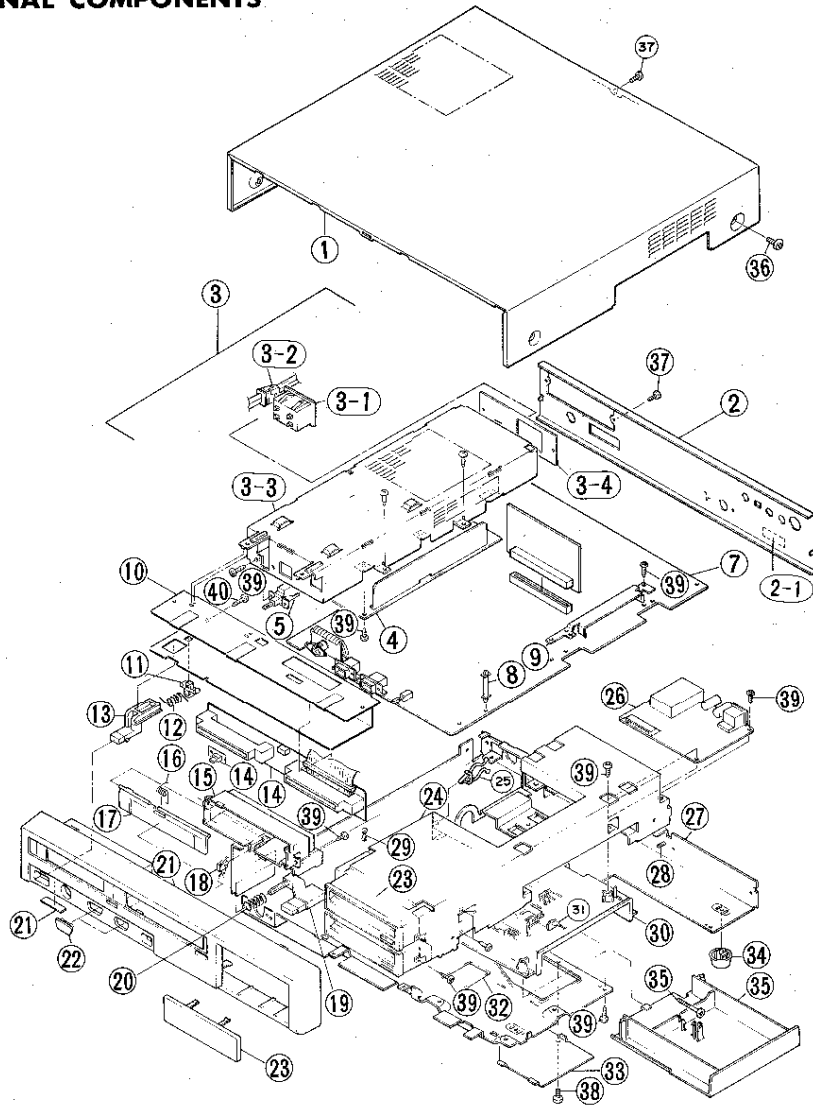


HOME PERSONAL COMPUTER

AX-500

PARTS LIST

EXTERNAL COMPONENTS



Ref. No.	Part No.	Description	品名	Remarks	ランク
※ 1	VB 75 73 00	Top Cover	トップカバー		
※ 2	VB 65 59 00	Rear Panel	リアパネル		
※ 2-1	VB 34 77 00	Label	SER.NO. ラベル		
※ 3	VB 65 07 00	AC Inlet Assembly	ACインレット Ass'y		
※ 3-1	VB 93 46 00	AC Outlet	電源コネクタ		

※ : New Parts (NR)

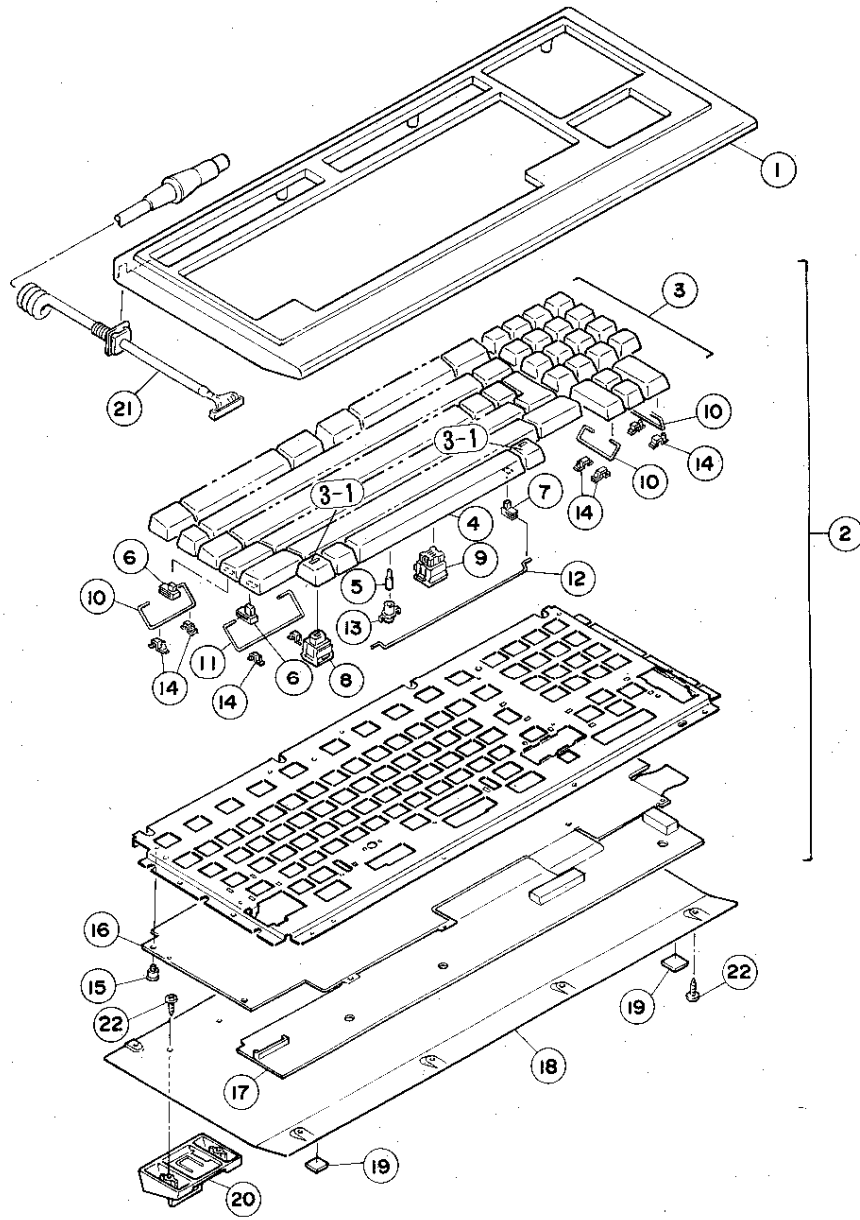
ランク: Japan only

Ref. No.	Part No.	Description	品 名	Remarks	ランク
3-2	MX 55 03 10	AC Cable	電 源 ケーブル		
3-3	VB 65 13 00	PW Upper Shield	PWアッパーシールド		
3-4	VB 65 14 00	PW Panel	PWパネ ル		
* 4	VB 65 75 00	Power Supply Unit	電 源 ユ ニ ッ ト		
5	VB 47 60 00	Power Switch	パ ワー ス イ ッ チ		
* 6	VB 84 79 00	Circuit Board	ROM Board	R O M シー ト	
* 7	VB 64 59 00	Circuit Board	CPU	C P U シー ト	
8	VB 34 68 00	PC Saport	P C サ ポ ー ト		
9	AA 55 40 20	Side Slot Earth	サイドスロットアース		
* 10	VB 33 05 00	Slot Stay	フロントスロットステー		
11	VB 75 79 00	Rod Holder	ロッドホルダー		
* 12	VB 75 76 00	Switch Spring	スイッチスプリング		
13	VB 32 97 00	Switch Button	ス イ ッ チ ボ タ ン		
* 14	VB 22 59 00	Circuit Board	SLOT	S L O T シー ト	
* 15	VB 32 93 00	Cartridge Slot	カートリッジスロット		
* 16	VB 33 07 00	Slot Door Spring	スロットドアスプリング		
* 17	VB 32 94 00	Upper Slot Door	アッパースロットドア		
* 18	VB 34 76 00	Micro Switch Assembly		マイクロSW Ass'y	
18	VA 04 10 00	Micro Switch	SCL101U	マイクロスイッチ	
18	LB 10 11 30	Terminal for Micro Switch		圧 着 端 子	
18	LB 00 90 30	Connector Housing	3P	コネクタハウジング	
* 19	VB 32 96 00	Cartridge Slot Eject		カートリッジスロットエジェクト	
* 20	VB 34 63 00	Eject Spring		エジェクトスプリング	
* 21	VB 65 65 00	Front Panel		フ ロ ン ト パ ネ ル	
22	CB 55 40 10	JOYSTICK Cover		ジョイスティックカバー	
23	VB 07 24 00	FDD Unit		F D D ユ ニ ッ ト	
* 24	VB 33 04 00	FDD Shield		F D D シー ル ド	
25	VB 75 78 00	Cable Clip		ケーブルクリップ	
* 26	VB 65 77 00	Circuit Board	Video	ビ デ オ シー ト	
* 27	VB 33 01 00	Bottom Chassis		ボトムシャーシ	
* 28	AA 62 73 10	GND Terminal		G N D ターミナル	
29	CB 83 19 80	Spacer	KGLS-10R	ロッキングカードスペーサ	
* 30	VB 32 98 00	Side Slot Guide		サイドスロットガイド	
31	LB 10 11 30	Terminal		圧 着 端 子	
31	LB 00 90 30	Connector Housing	3P	コネクタハウジング	
31	BB 55 00 60	Terminal (+)	MSX2	バッテリー端子(+)	
31	BB 55 00 70	" (-)	MSX2	" (-)	
31	NB 55 27 90	Battery Cable Assembly		バッテリーケーブルAss'y	
* 32	VB 33 00 00	Battery Lock		バッテリーロック	
33	VB 33 06 00	FDD Door		F D D ドア	
34	VB 34 59 00	Leg		ト ラ ン レ ッ グ	
* 35	VB 65 70 00	Side Slot Cover Assembly		サイドスロットカバーAss'y	
35	EX 55 00 10	Bind Head Screw	3.0X30	コインスリワリツキネジ	
36	EK 36 50 20	BW Bind Head Screw	4.0X6 FCM3BL	B W ヘ ッ ド ネ ジ	
37	ED 33 00 66	Bind Head Screw	3.0X6 FCM3BL	バ イ ン ド C タ イ ト	
38	VB 34 65 00	Pan Head Boning Screw	3.0X6 FCRM3BL	コ イ ン ナ ベ ー ッ ク タ イ ト	
39	Ei 33 00 86	Bind Head Tapping Screw	3.0X8 FCM3BL	バ イ ン ド タ ッ ピ ン グ ネ ジ	
40	Ei 33 01 46	"	3.0X14 ZMC2BL	"	

* : New Parts (NR)

ランク: Japan only

■ KEYBOARD COMPONENTS



Ref. No.	Part No.	Description	品 名	Remarks	ランク
* 1	VB 65 79 00	Upper Case		ア ッ パ ー ケ ー ス	
* 2	VB 68 28 00	Keyboard Unit		キ ー ボ ー ド ユ ニ ッ ト	
3	CX 55 82 40	Key Top Set(Other S,C,K)		キ ー ト ッ プ セ ッ ト	A7KN037
3-1	CX 55 73 10	" (for S,C,K)	for LED KEY	キ ー ト ッ プ セ ッ ト L E D 用	D2KN0011
4	CX 55 73 20	Key Top for SPACE Bar		ス ペ ー ス バ ー キ ー ト ッ プ	80D9M 27000
5	AX 55 02 50	Key Top Guide Pin	SPACE Bar	キ ー ト ッ プ ガ イ ド ピ ン	16KF006
6	AX 55 02 60	Lever Hook	Key Top(Middle)	レ バ ー フ ッ ク (キ ー ト ッ プ 用)	21KC013
7	AX 55 02 70	"	SPACE Bar	" (ス ペ ー ス キ ー 用)	21KC022
8	NX 55 03 00	Switch Assembly	CAPS, CODE	ス イ ッ チ 駆 動 Ass'y	D4KN001
9	KX 55 04 60	Push Switch	for CAPS, CODE	プ ッ シ ュ ス イ ッ チ	SKCLFA000A
10	AX 55 02 20	Lever	l=1.75	レ バ ー	21KC005
11	AX 55 02 30	"	l=2.5	"	21KC006
12	AX 55 02 40	"	for SPACE Bar	"	21KC020
13	AX 55 70 00	Guide	for SPACE Bar	ス ペ ー ス バ ー ガ イ ド	16KC004
14	AX 55 70 10	Lever Hinge		レ バ ー ヒ ン ジ	19KC003
15	EX 55 00 20	Special Screw		特 殊 ネ ジ	50KN001
16	NX 55 05 80	A Point of Contact		接 点 Ass'y	B2KN020
17	NX 55 06 00	Circuit Board Assembly		基 盤 Ass'y	A4KN009
	iG 11 97 00	IC	SN74LS31N	I C	
	iG 04 96 50	"	SN74LS125AN	"	
	iG 12 41 00	"	SN74LS145N	"	
	iG 05 01 00	"	SN74LS175N	"	
	iC 07 52 20	Transistor	2SC752	ト ラ ン ジ ス タ	
	iF 00 03 30	Diode	1S188	ダ イ オ ー ド	
	FG 74 34 70	Ceramic Cap.	4700PF	セ ラ コ ン	
	FJ 14 82 20	Electrolytic Cap.	220 μ F 16V	ケ ミ コ ン	
	LX 55 07 30	Connector		コ ネ ク タ	4N16005
	LX 55 07 40	"		"	4N16006
	LX 55 07 50	"		"	4N00605
* 18	VB 33 16 00	Bottom Case		ボ ト ム ケ ー ス	
* 19	VB 34 80 00	Foot		ス ベ リ 座	
* 20	VB 65 61 00	Snap Foot Assembly		ス ナ ッ プ フ ッ ト Ass'y	
* 21	VB 34 79 00	Wire Kit	13P	束 線 キ ッ ト	
* 22	EI 33 00 86	Bind Head Tapping Screw	3XB FCM3BL	バ イ ン ド タ ッ ピ ン グ ネ ジ	PACK

* : New Parts (NR)

ランク: Japan only

ELECTRONIC PARTS

Ref. No.	Part No.	Description	品 名	Remarks	ランク
*	VB 64 59 00	Circuit Board	CPU	C P U シ ー ト	AX-500
IC337	IG 12 19 00	IC	LH0080A	CPU	
IC349	XA 03 70 03	"	V9938	VDP(IC)	
IC303	XA 83 40 01	"	S1985 (YM-3814)	MPS2	
IC301	XA 91 30 01	"	SED9420C	D Separator	
IC302	IG 05 73 00	"	MB8877M	FDC	
IC321	IG 09 89 00	"	HD74LS11	AND	
IC309	IG 05 01 00	"	HD74LS175P	DFF	
IC310	IG 05 05 00	"	HD74LS368AP	DRIV	IC305
IC359	IG 11 53 00	"	HD74LS670P	R. FILE	
IC344	IG 13 49 00	"	IR9311	Comparater	
IC353	IG 00 13 90	"	NJM4558DV	OP Amp.	
IC357	IG 12 43 00	"	PST5 18A	RESET	
IC312	IG 02 69 10	"	HD74LS00P	NAND	
IC307	IG 02 70 10	"	HD74LS04P	INV	IC305
IC313	IG 05 91 00	"	SN74LS06	INV/BUF	
IC316	IG 04 37 50	"	SN74LS08N	AND	
IC315	IG 04 96 50	"	SN74LS14N	INV	IC308, 316
IC358	IG 04 97 50	"	SN74LS30N	NAND	IC341
IC304	IG 04 98 50	"	SN74LS32N	OR	IC317, 346, 347
IC306	IG 04 42 00	"	HD74LS138P	3-8 DEC	
IC314	IG 04 99 00	"	HD74LS139P	DEC	
IC326	IG 06 00 50	"	SN74LS244N	DRIV	
IC334	IG 04 46 00	"	SN74LS245	TRAN.	
IC325	IG 07 16 00	"	SN74LS367N	DRIV	IC330, 333
IC356	IG 06 03 50	"	SN74LS373N	LA TCH	
IC311	XA 05 50 01	"	SN74ALS32N	OR	IC352
IC339	IG 05 10 00	"	TC40H004P	INV	
IC345	IR 00 00 00	"	TC74HC00P	NAND	
IC319	IR 01 57 00	"	TC74HC157P	DATA-SE	IC322
IC343	IG 14 22 00	"	TC74HCU04	INV	
IC323	XA 45 70 01	"	MB81464-12	256K DRAM	IC327, 329, 331, 335, 338, 340, 342
IC320	XB 75 00 03	"	MSX2-BASIC INT	ROM	
IC328	XB 75 10 05	"	MSX2EX, DISC INT	"	
IC332	XB 25 60 02	"	YRG G.BIOS-L	"	
IC336	XB 25 70 02	"	YRG G.BIOS-H	"	
IC324	XB 20 30 07	"	ARABIC-OS, V2.0	"	
TR305	IA 09 33 00	Transistor (TR307, 308, 310)	2SA933S R	ト ラ ン ジ ス タ	
TR302	IC 17 40 00	" (TR303, 304, 306, 309)	2SC1740S R, S	"	
D304	VA 93 09 00	Diode (D305)	1SS114	ダ イ オ ー ド	
D301	IF 00 34 50	" (D302, 303, 306-313)	1SS133, 1SS176	"	
FA 15 31 20	Mylar Cap.		0.0012 μ F 50V K	マ イ ラ ー コ ン	
FA 15 31 50	"		0.0015 μ F 50V K	"	
FA 15 33 30	"		0.0033 μ F 50V K	"	
FA 15 41 10	"		0.01 μ F 50V K	"	
FA 15 42 20	"		0.022 μ F 50V K	"	
FA 15 44 70	"		0.047 μ F 50V K	"	
FA 15 51 00	"		0.1 μ F 50V K	"	
FG 41 11 50	Ceramic Cap.		15PE 50V K	セ ラ コ ン	
FG 41 12 20	"		22PE 50V K	"	
FG 41 12 70	"		27PF 50V K	"	

* : New Parts (NR)

ランク: Japan only

Ref. No.	Part No.	Description	品 名	Remarks	ランク
	FG 41 13 90	Ceramic Cap.	39PF 50V K	セラコン	
	FG 41 16 80	"	68PF 50V K	"	
	FG 44 41 00	"	0.01 μ F 50V Z	"	
	UJ 13 82 20	Electrolytic Cap.	220 μ F 16V	ケミコン	
	UJ 12 82 20	"	220 μ F 10V	"	
	UJ 13 81 00	"	100 μ F 16V	"	
	UJ 14 72 20	"	22 μ F 25V	"	
	UJ 12 81 00	"	100 μ F 10V	"	
	UJ 12 84 70	"	470 μ F 10V	"	
	UJ 16 81 00	"	1 μ F 50V	"	
	UJ 16 82 20	"	2.2 μ F 50V	"	
	UJ 16 64 70	"	4.7 μ F 50V	"	
	UJ 13 71 00	"	10 μ F 16V	"	
	UK 34 64 70	"	4.7 μ F 25V	BPケミコン	
	FZ 00 41 10	Semiconductive Cera.	0.1 μ F 16V M	半導体セラコン	
* TC301	VB 65 04 00	Variable Resistor	30PF CTZ-51F	可変コンデンサ	
TC302	RM318 HZ 00 28 70	Resistor Array	RMLS4-103J	抵抗アレイ	
	RM306 HZ 00 46 60	" (RM308,310,316,319,320)	RMLS8-103J	"	
	RM304 HZ 00 51 20	" (RM315,317)	RMLS4-102J	"	
	RM305 VA 06 97 00	" (RM313)	RMLS4-472J	"	
	RM302 VA 09 22 00	" (RM303,307,309,311,312)	RMLS8-223J	"	
* RM301	VB 65 00 00	"	RMLS8-222J	"	
L301	GE 30 03 50	Coil	68 μ H	コイル	
CR304	QU 00 92 00	Quartz Crystal Unit	21.4773MHz	水晶振動子	
CR301	VA 07 09 00	"	32.768KHz	"	
CR303	VC 01 26 00	"	3 5795MNz	"	
CR302	VB 65 06 00	Ceramic Resonator	16MHz	セラミック振動体	
	FI 36 32 20	EMI Filter	LS NIT X222MB	EMIフィルター	
	VB 45 27 00	"	EXC-EMT271T	"	
	VB 45 28 00	"	EXC-EMT471T	"	
	VB 45 30 00	"	EXC-EMT222J	"	
SW1	VA 06 69 00	Push Switch	SPJ-312U	プッシュスイッチ	
RL301	VB 59 82 00	Relay	DC AG4019	リレー	
	AA 55 40 00	Heat Sink		VDPヒートシンク	
	LB 60 73 30	IC Socket		ICソケット	
	VB 64 55 00	PC Joiner		PCジョイナー	
CN315	VB 09 77 00	Connector	8P	DINコネクタ	
	CN301 VB 24 54 00	"	13P TCS1001-01-202	"	
	CN314 VB 00 79 00	"	14P	アンフェノール	
	CN313 VB 32 12 00	"	50P D05-50SA -1L1	コネクタ	
	CN302 LB 60 80 50	" (CN303)	9P	"	
	CN309 LB 91 80 30	Base Post	3P I-TYPE	ベースポスト	
	CN304 LB 93 20 40	"	4P	"	
	CN308 VB 32 11 00	Header	50P	ヘッダー	
	VB 31 70 00	Wire Kit	13P	束線キット(Video)	Video Unit
	VB 31 71 00	"	4P	" (FDD)	FDD PU
	VB 31 72 00	"	34P	" (FDD)	FDD Unit
	VB 31 76 00	"	50P	" (SLOT)	SLOT C,B
	VB 84 79 00	Circuit Board	ROM Board	ROMシート	

* : New Parts (NR)

ランク: Japan only

AX-500 POWER SUPPLY UNIT ELECTRONIC COMPONENTS (VB657500)

Ref. No.	Part No.	Description	品名	Remarks	ランク
IC101	IX 55 31 10	IC	IR9431	シャフトレギュレータ	
* PC101	IX 55 44 00	"	PC817	フォトカブラ	
* Q101	IX 55 44 10	Transistor	2SC3376	トランジスタ	
* Q102	IX 55 44 20	"	2SC2655-Y	"	
Q104,105	IC 18 15 30	"	2SC1815-GR	"	
Q106	IA 10 15 30	"	2SA1015-GR	"	
Q104	IX 55 31 40	"	2SC3303-Y	"	
Q107	IX 55 31 50	"	2SC2877-Y	"	
D101	IX 55 39 00	Diode	S1WB60	ブリッジダイオード	
D102	IX 55 39 10	"	F1-08	ファーストリカバリダイオード	
D103	IX 55 31 80	"	1SS144	シリコンダイオード	
D104,105	IF 00 06 70	"	1S2473	"	
D106	IX 55 31 70	"	ESAC82M-004	ショットキーバリアダイオード	
* D107	IX 55 44 30	"	SM-3-02FRLF	ファーストリカバリダイオード	
D108,109	IX 55 39 20	"	F1-02	"	
T101	GX 55 06 20	Switching Transformer		スイッチングトランス	EI-35
L101	GX 55 04 20		752YOR4	スモンモードチョーク	
L102	GX 55 04 30	Coil (Rod type)	10 μ H	棒状 チョークコイル	
L103,104	GX 55 04 40	" (Drum type)	10 μ H	ドラム "	
* C102,103	FX 55 15 80	Ceramic Cap.	0.0022 μ F 4KV	セラミックコンデンサ	TYPE KD
* C106	FX 55 15 90	"	0.00033 μ F 1KV	"	TYPE KD
C101	FX 55 10 80		0.1 μ F 250VAC	メタライズドコンデンサ	TYPE VE
C105	FX 55 10 80		0.01 μ F 630V	"	TYPE MMH
* C107	FA 46 43 30		0.033 μ F 50V	ポリエステルコンデンサ	TYPE AMZ
C108,110	FX 55 12 10		0.047 μ F "	"	"
* C109	FA 15 51 00		0.1 μ F "	"	"
C104	FX 55 16 00	Electrolytic Cap.	150 μ F 400V	電解コンデンサ	
C111	UJ 72 94 70	"	4700 μ F 10V	"	
C112	UJ 12 92 20	"	2200 μ F "	"	
C113-116	UJ 42 83 30	"	330 μ F "	"	
C119	UJ 13 81 00	"	100 μ F 16V	"	
C118	UW67 64 70	"	4.7 μ F 63V	"	
C117	UJ 16 61 00	"	1 μ F 50V	"	
R108	HL 32 61 50	Metal Oxide Resistor	1.5 Ω 2W	酸化金属被膜抵抗	
R106,107	HL 32 61 00	"	1K Ω "	"	
R102,103	HL 32 76 80	"	68K Ω "	"	
R104,105	HL 32 81 00	"	100K Ω "	"	
R110,111	HX 55 17 40	"	47 Ω 3W	"	
R116	HL 31 52 20	Carbon Resistor	220 Ω 1/2W	カーボン抵抗	
R117,118	HL 31 58 20	"	820 Ω "	"	
R122	HL 30 71 00	"	10K Ω "	"	
R113	HJ 35 41 00	"	10 Ω 1/4W	"	
R119	HJ 35 44 70	"	47 Ω "	"	

* : New Parts (NR)

ランク: Japan only

■ AX-500 POWER SUPPLY UNIT ELECTRONIC COMPONENTS

Ref. No.	Part No.	Description	品 名	Remarks	ランク
R114	HJ 35 45 60	Carbon Resistor	56Ω 1/4W	カーボン抵抗	
R123,124 126	HJ 35 51 00	"	100Ω "	"	
R125	HJ 35 52 70	"	270Ω "	"	
R115	HJ 35 53 30	"	330Ω "	"	
R112	HJ 35 55 60	"	560Ω "	"	
R109	HJ 35 61 20	"	1.2KΩ "	"	
R120	HJ 35 63 00	"	3KΩ "	"	
R121	HJ 35 63 60	"	3.6KΩ "	"	
R127	HJ 35 81 00	"	100KΩ "	"	
R101	HX 55 16 40	Cement Resistor	3.3Ω 3W	セメント抵抗	
VR101	HX 55 14 00	Variable Resistor	1KΩ	半固定抵抗	
	LX 55 06 90	Fuse Clip		ヒューズクリップ	
	KB 00 23 60	Fuse	T2A 250V	ヒューズ	
	LX 55 06 00	Connector	5277-02A	コネクタ 2P	
	NX 55 06 30	"		コネクタ 3P Ass'y	
	NX 55 06 40	"		コネクタ 4P Ass'y	
	AX 55 02 80	Support Transistor		サポートトランジスタ	
	CX 55 60 20	Heat Sink Tube	サーコンFR, t=0.45	チューブタイン	
	BX 55 00 90	Heat Sink		放熱板	
	BX 55 01 00	"	Al, 2t	"	
	EV 41 00 36	Washer Pan Head Screw	M3×8プラス	妻付産金付ナベ小ネジ	PC板・放熱板
	ED 03 00 66	Bind Head Screw	M3×8プラス	バインド小ネジ	トランジスタ放熱板
	EI 03 01 46	Bind Head Tapping Screw	3×14バインドプラス	タッピングネジ	サポートトランジスタ

* : New Parts (NR)

ランク: Japan only

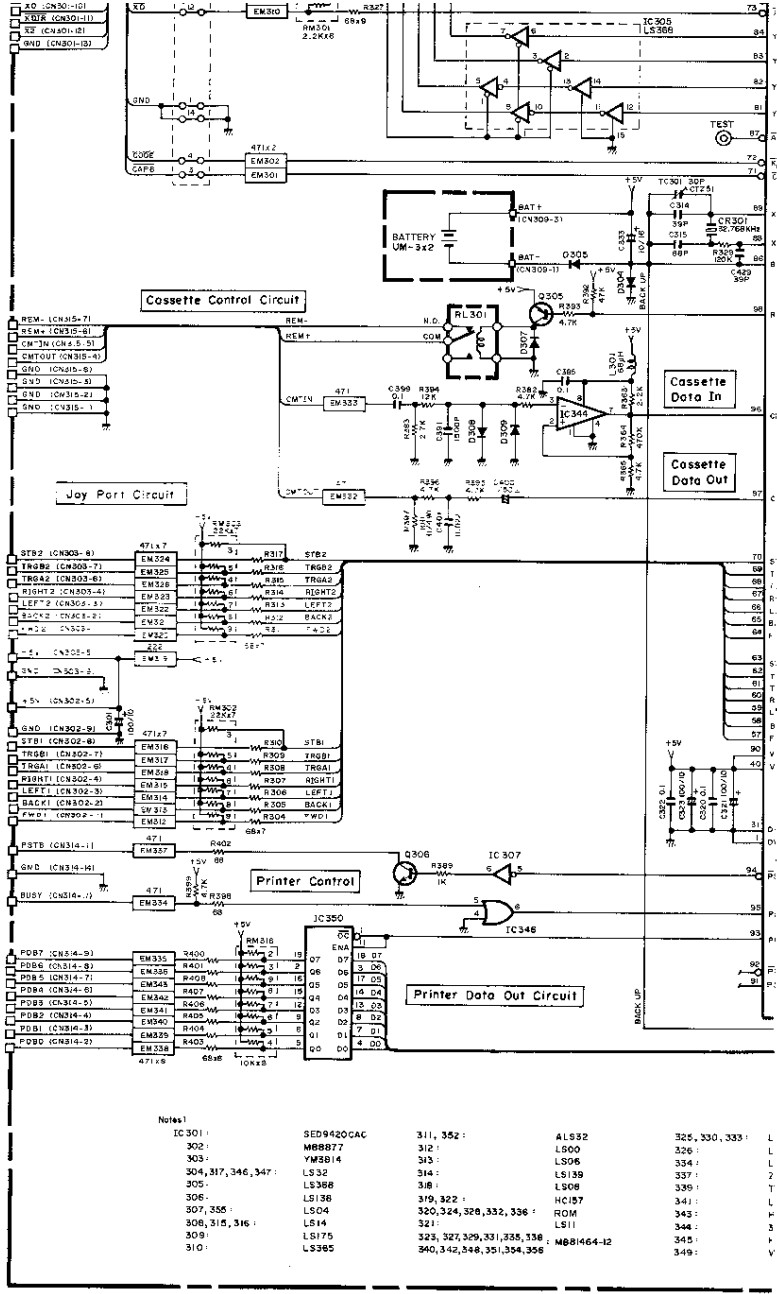
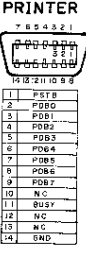
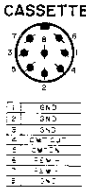
AX-500 VIDEO MODULE UNIT ELECTRONIC COMPONENTS (VB657700)

Ref. No.	Part No.	Description	品名	Remarks	ランク
IG	02 70 10	IC	74LS04	I C	IC201
IX	55 28 90	"	LVA510	"	IC202
HJ	35 41 80	Resistor	18Ω 1/4W	抵 抗	R243~245
HF	85 46 80	"	68Ω 1/6W	"	R217,222
HF	85 52 20	"	220Ω "	"	R201,202,205,216,256
HF	85 55 60	"	560Ω "	"	R246,254
HF	85 56 80	"	680Ω "	"	R204,240
HF	85 58 20	"	820Ω "	"	R210
HF	85 61 00	"	1KΩ "	"	R207,209,223,228,229,231,234,236
HF	85 61 80	"	1.8KΩ "	"	R203,224,255
HF	85 62 20	"	2.2KΩ "	"	R249,253
HF	85 63 30	"	3.3KΩ "	"	R206
HF	85 66 80	"	6.8KΩ "	"	R225
HF	85 71 00	"	10KΩ "	"	R214,218,233,248
HF	85 71 50	"	15KΩ "	"	R215
HF	85 72 20	"	22KΩ "	"	R212
HF	85 73 90	"	39KΩ "	"	R230,252
HF	85 75 60	"	56KΩ "	"	R231,251
HF	85 76 80	"	68KΩ "	"	R250
			1.8KΩ or 4.7KΩ		R245
UJ	12 81 00	Electrolytic Cap.	100μ 10V	ケ ミ コ ン	C207,210,233
UJ	12 83 30	"	330μ "	"	C211,227~229
UJ	13 71 00	"	10μ 16V	"	C201~204,217
UJ	13 81 00	"	100μ "	"	C205,231
UJ	16 61 00	"	1μ 50V	"	C216,218
FG	21 11 80	Ceramic Cap.	18P	セ ラ コ ン	C237
FG	21 12 20	"	22P	"	C238
FG	21 15 60	"	56P	"	C213
FG	21 13 90	"	39P	"	C212,220,236
FG	21 21 00	"	100P	"	C215,221
FG	21 21 50	"	150P	"	C219,225
FG	21 22 20	"	220P	"	C222,223
FG	21 24 70	"	470P	"	C209,234
FG	41 31 00	"	1000P	"	C215,235
FG	44 42 20	"	22000P	"	C206,208,209,214,230,232
IC	23 20 30	Transistor	2SC458	ト ラ ン ジ ス タ	Q204,205,207,208,110,111
		"	2SC1684	"	Q201~203,206
		"	2SC1317	"	Q209
IX	55 30 90	Diode	1SS106	ダ イ オ ー ド	D201~203
IX	80 11 90	"	1SS119	"	D204~207
HX	55 13 70	Present Potentiometer	2K	プ リ セ ッ ト	VR201
HX	55 13 80	"	10K	"	VR202
GX	55 03 60	Inductor	22μH	イ ン ダ ク タ ー	L201
GX	55 06 00	"	33μH	"	L202
QX	55 00 40	Quartz Resonator	4.433619MHz	水 晶 振 動 子	X201
KX	55 04 30	Slide Switch		ス ラ イ ド S.W.	SW201

* : New Parts (NR)

ランク: Japan only

1	5V
2	5V
3	5V
4	5V
5	5V
6	5V
7	5V
8	5V
9	5V
10	5V
11	5V
12	5V
13	GND



Notes:

IC 301 :	SED9920CAC	311, 352 :	4LS32	325, 330, 333 :	L
302 :	M88877	312 :	LS00	326 :	L
303 :	YM8814	313 :	LS06	334 :	L
304, 317, 346, 347 :	LS32	314 :	LS139	337 :	2
305 :	LS386	315 :	LS08	339 :	T
306 :	LS136	319, 322 :	HC187	341 :	L
307, 355 :	LS04	320, 324, 326, 332, 336 :	ROM	343 :	F
308, 315, 316 :	LS14	321 :	LS11	344 :	3
309 :	LS175	323, 327, 329, 331, 335, 338 :	M881464-12	345 :	V
310 :	LS395	340, 342, 348, 351, 354, 356 :		349 :	V

7

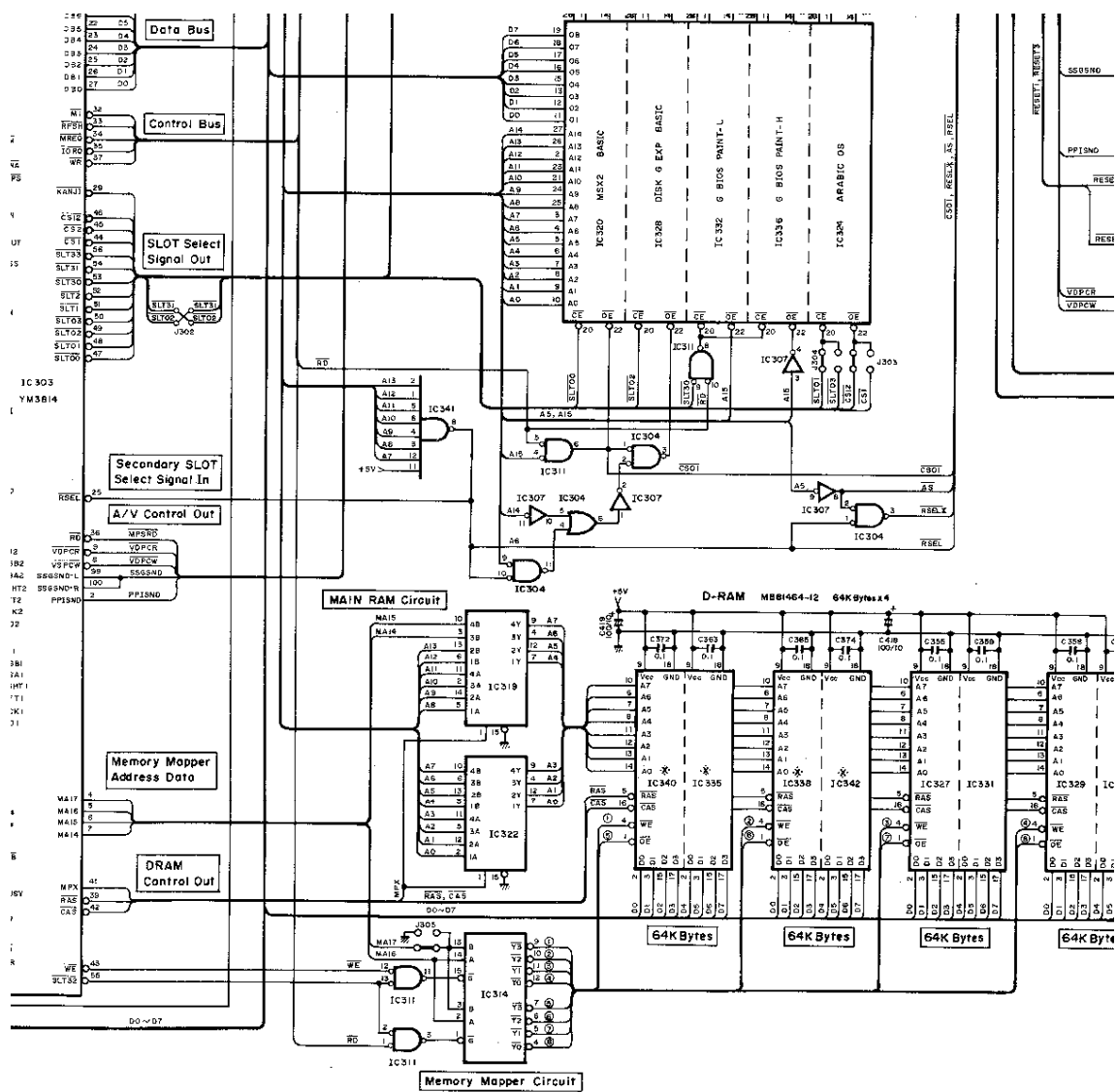
8

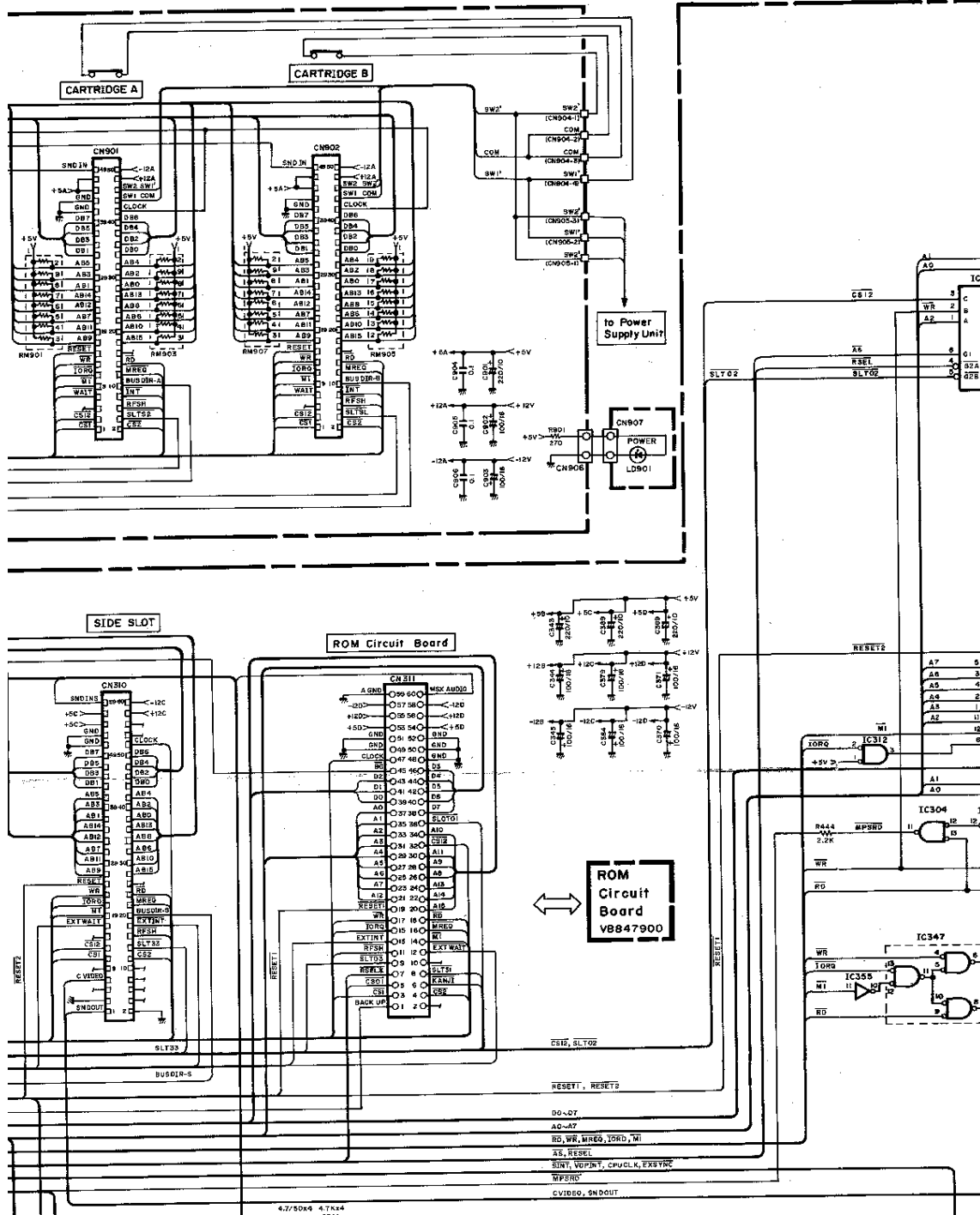
9

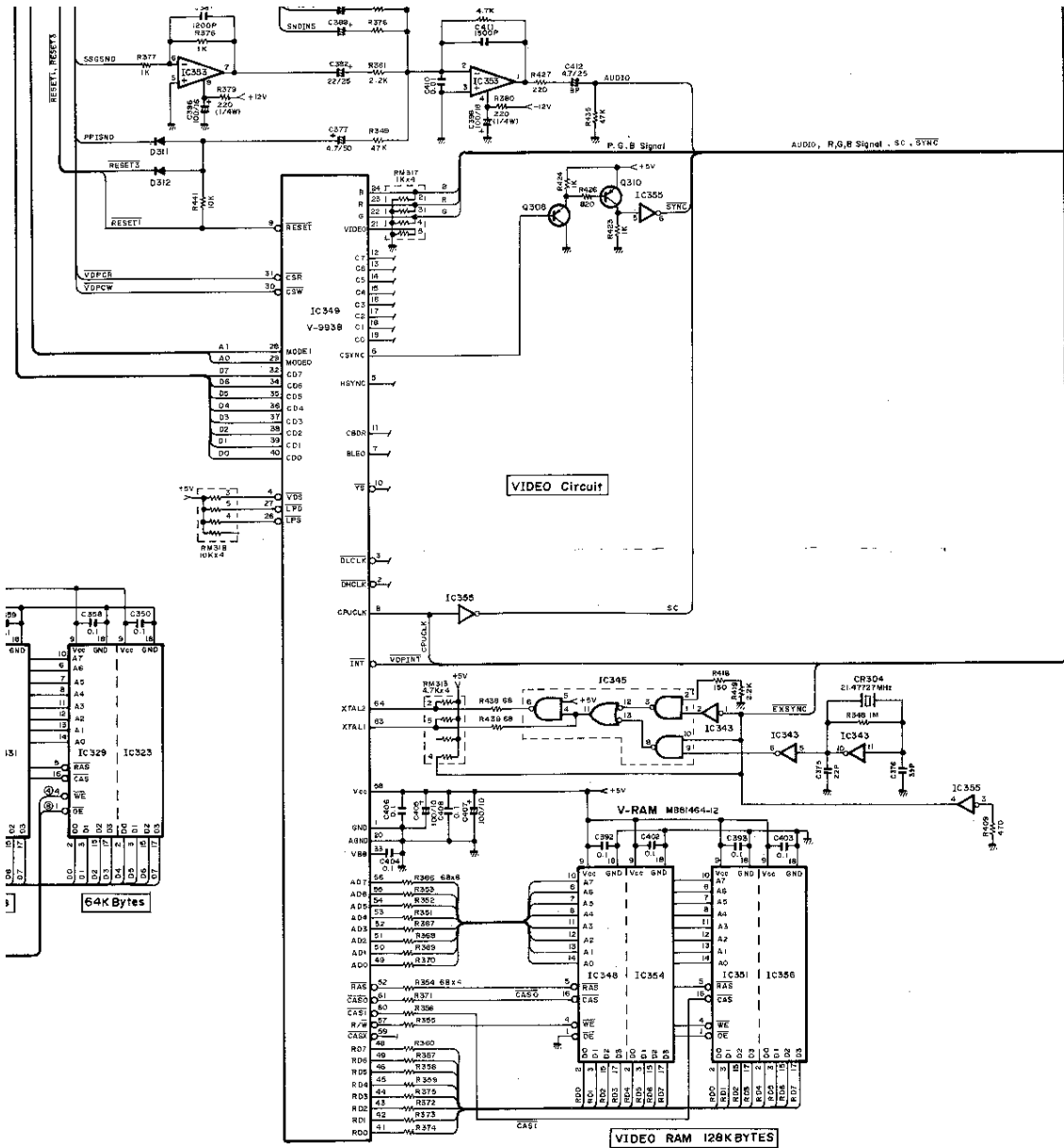
10

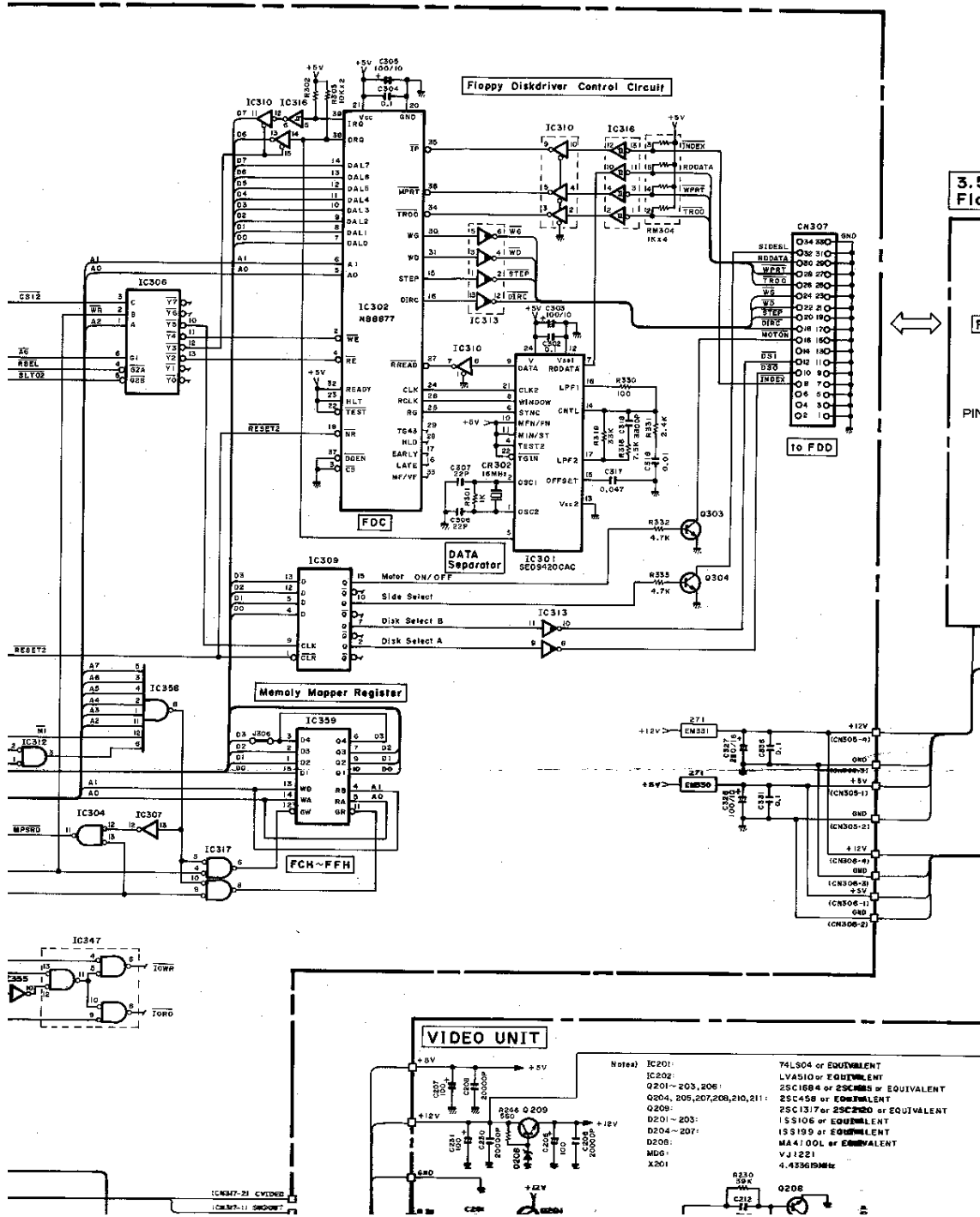
11

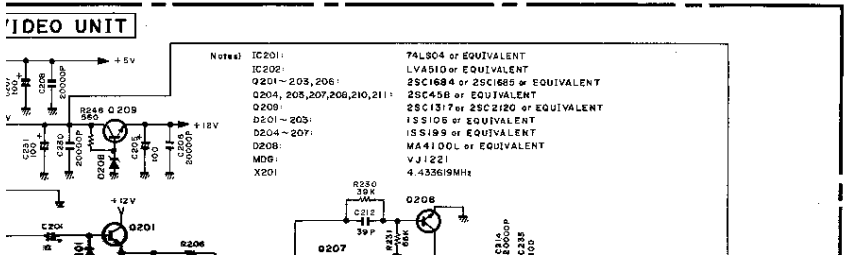
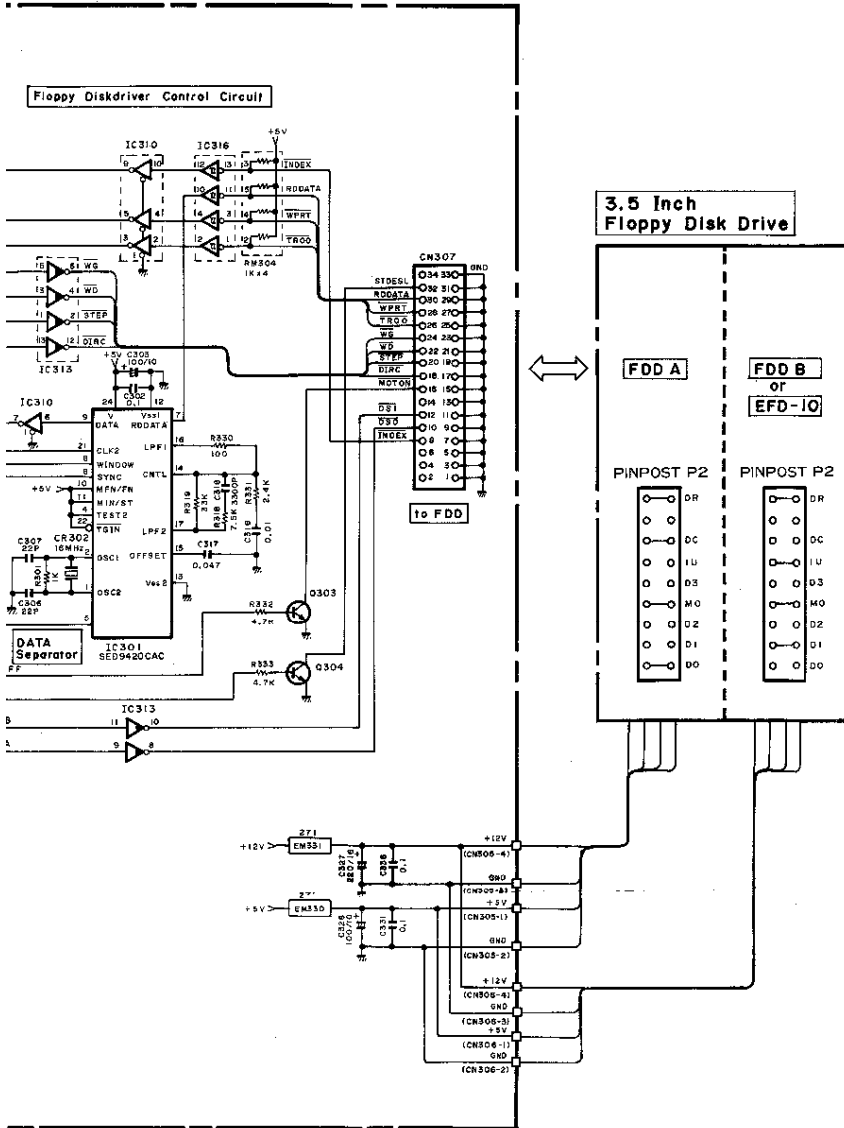
12

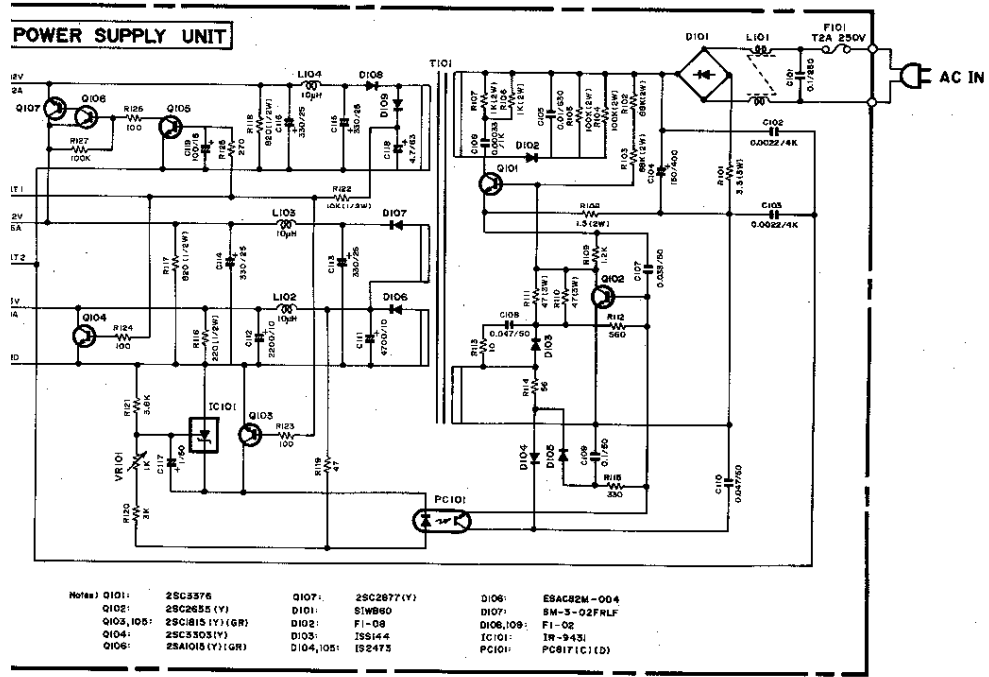
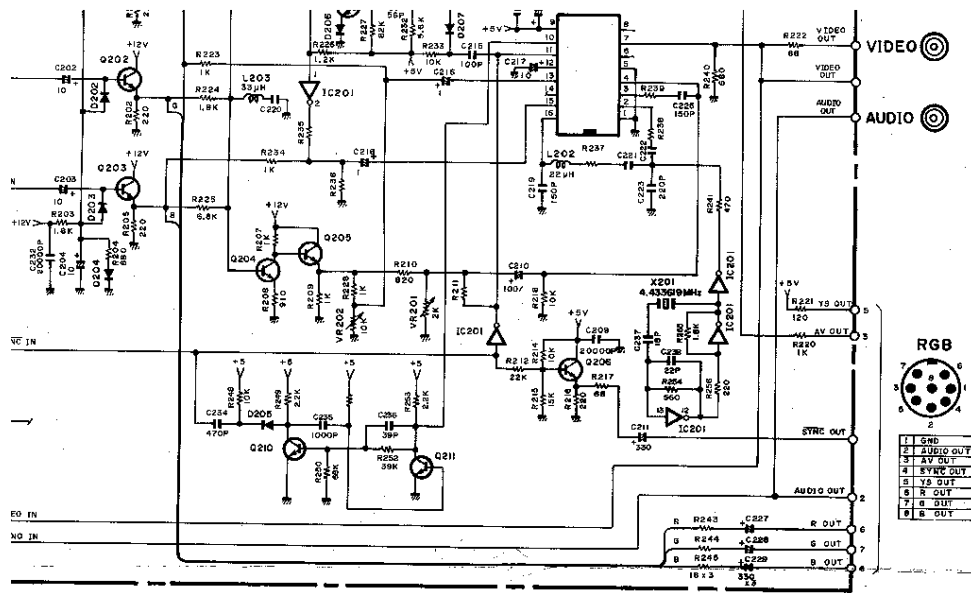




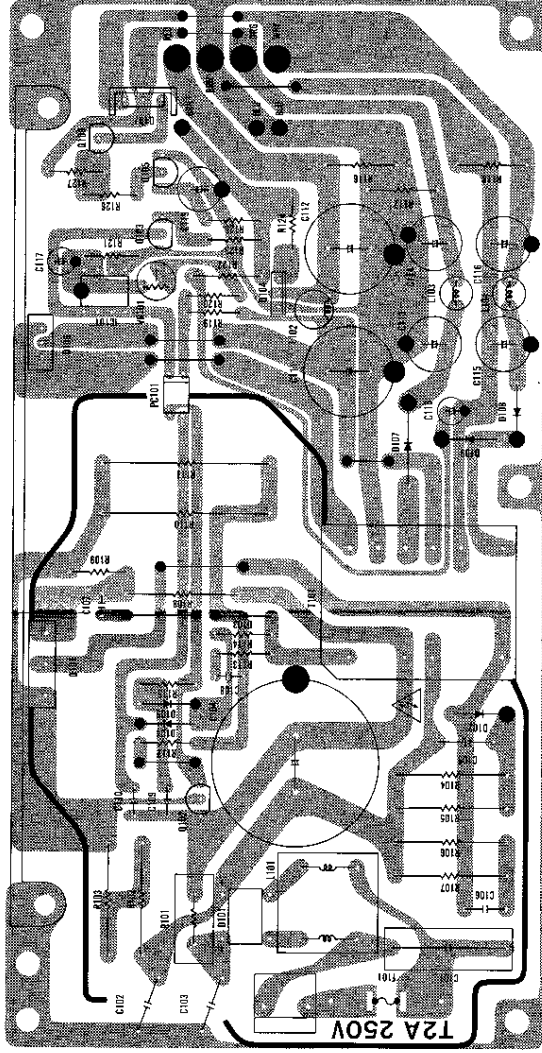
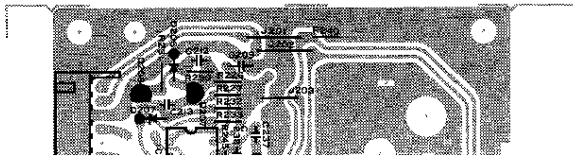








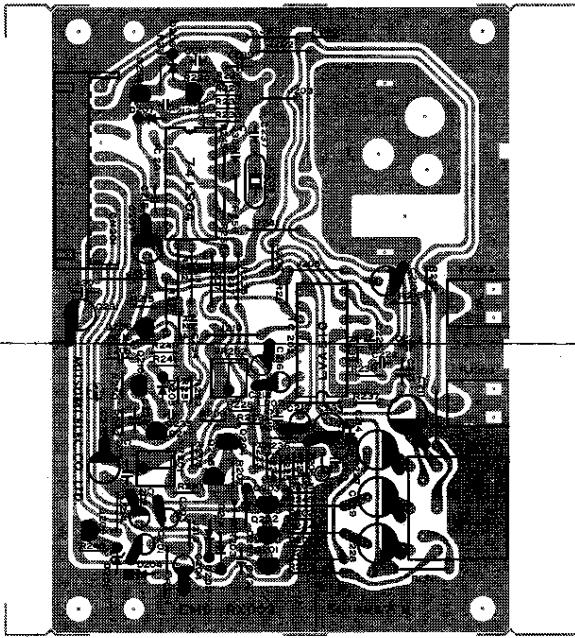
■ POWER SUPPLY UNIT CIRCUIT BOARD



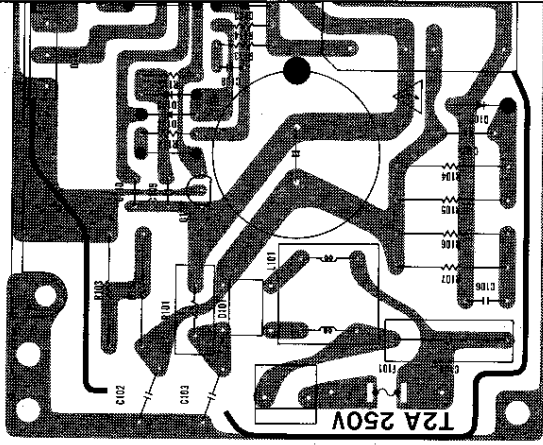
■ SUB ROM CIRCUIT BOARD



■ VIDEO UNIT CIRCUIT BOARD



■ POWER SUPPLY UNIT CIRCUIT



■ SLOT CIRCUIT BOARD

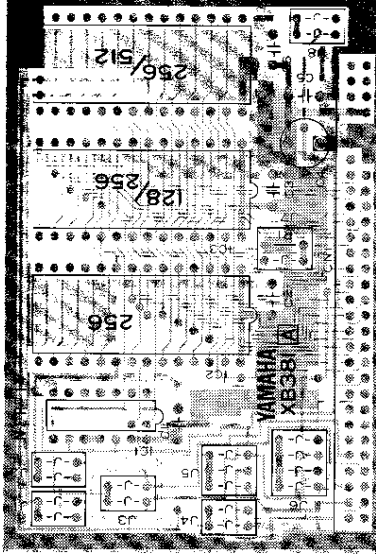
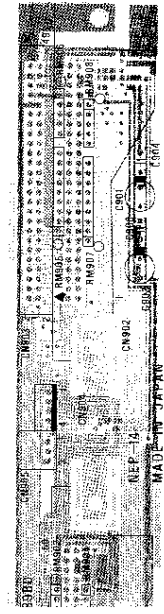


■ SUB ROM CIR



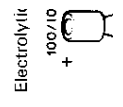
■ SUB ROM CIRCUIT BOARD

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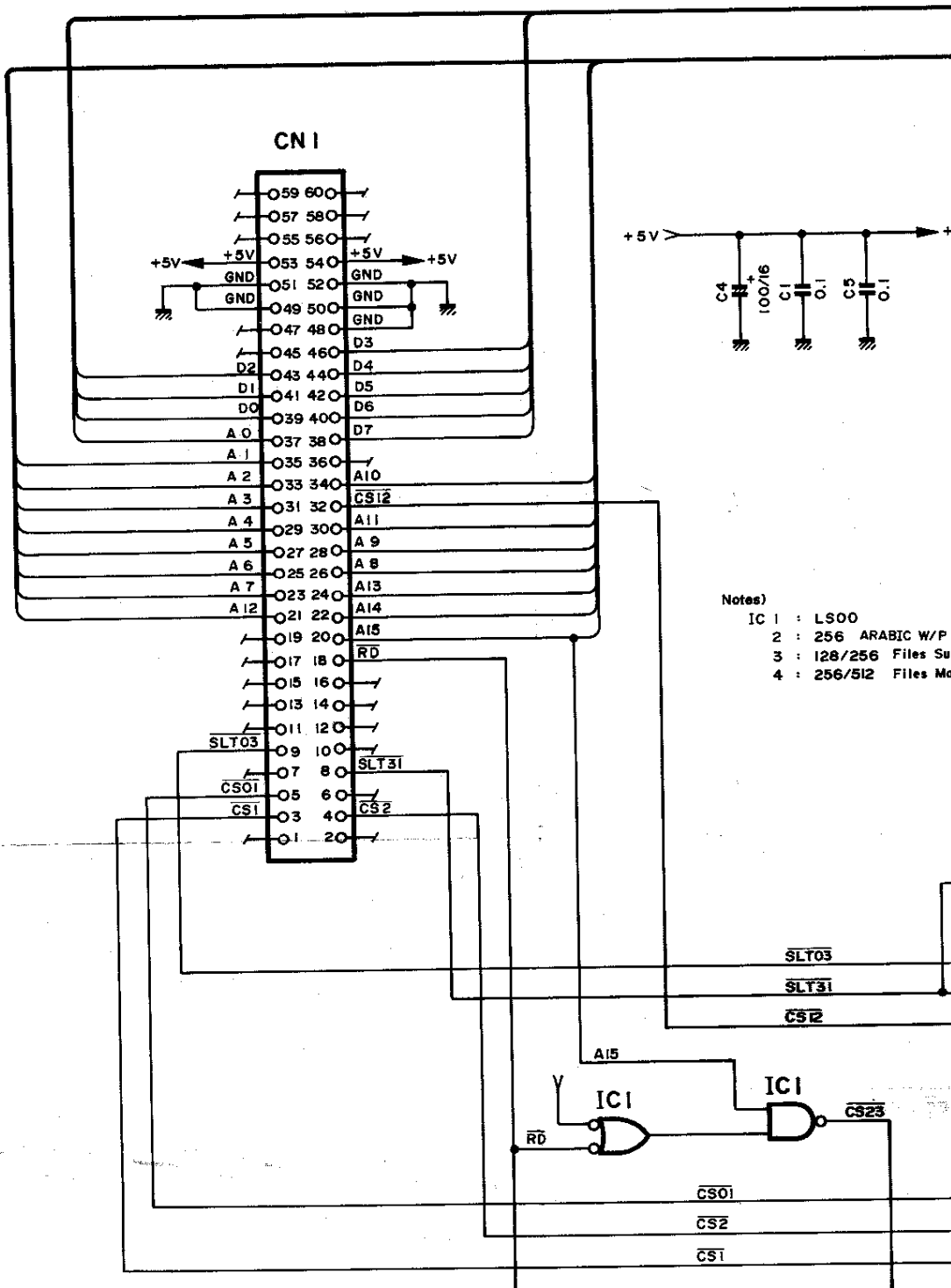


● Note 4
 Connect each +5V side of C311 and C320 with a jumper wire.

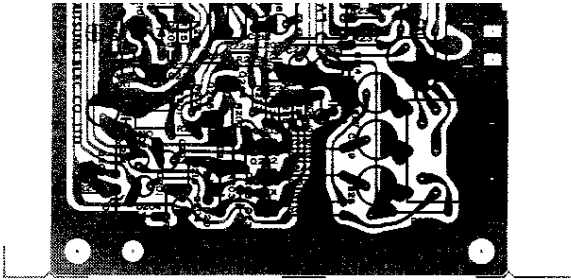
PC joiner (50mm 14 core)
 VB64550



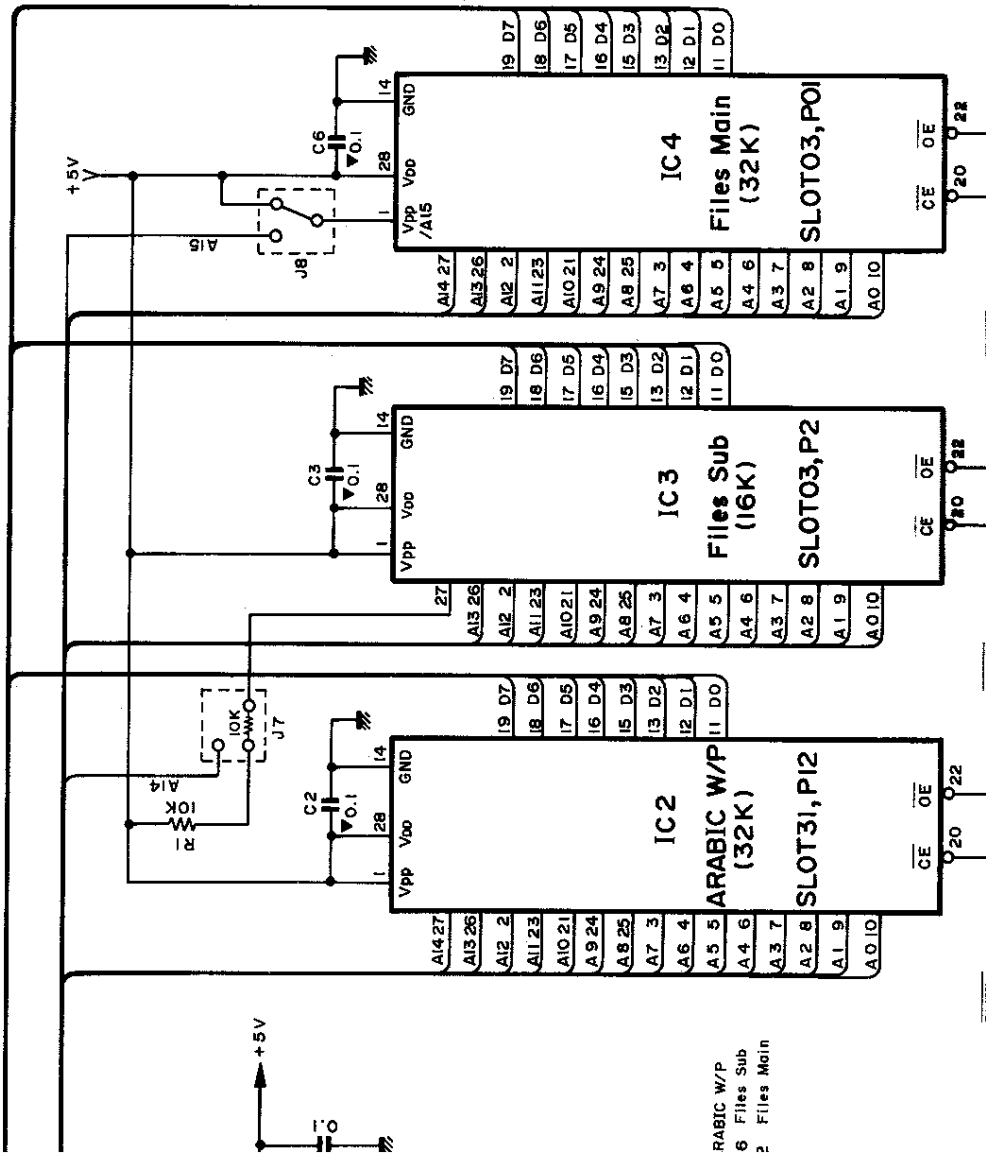
■ AX-500 ROM

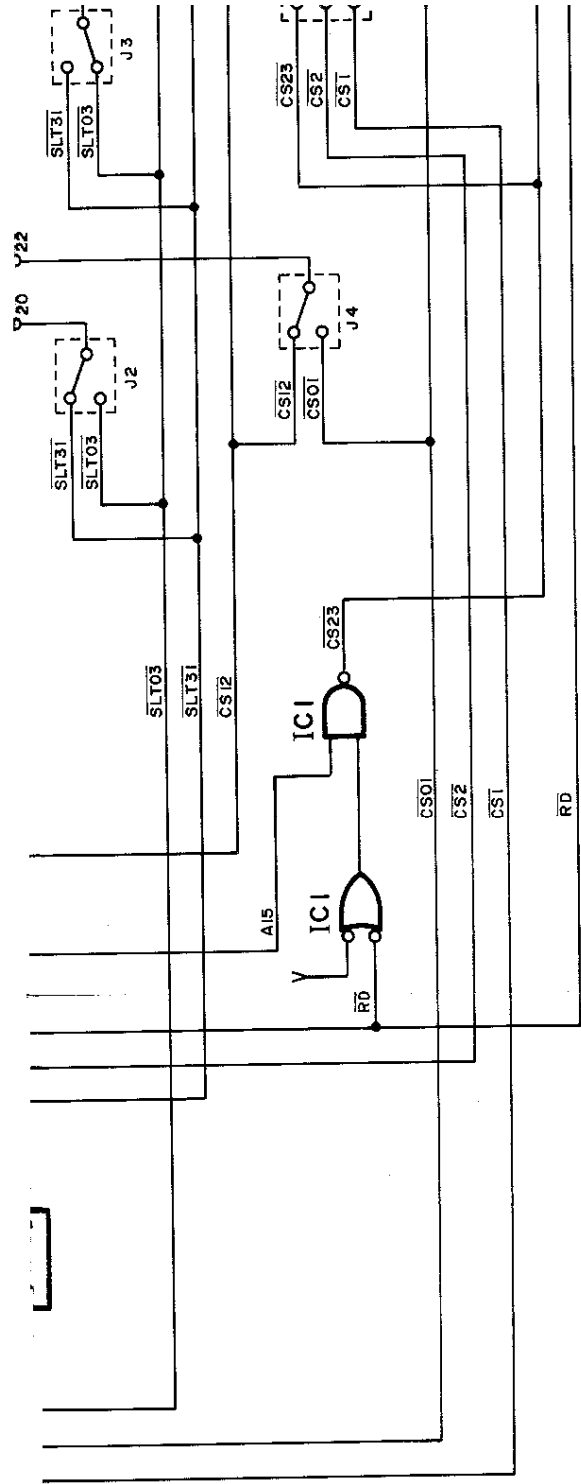


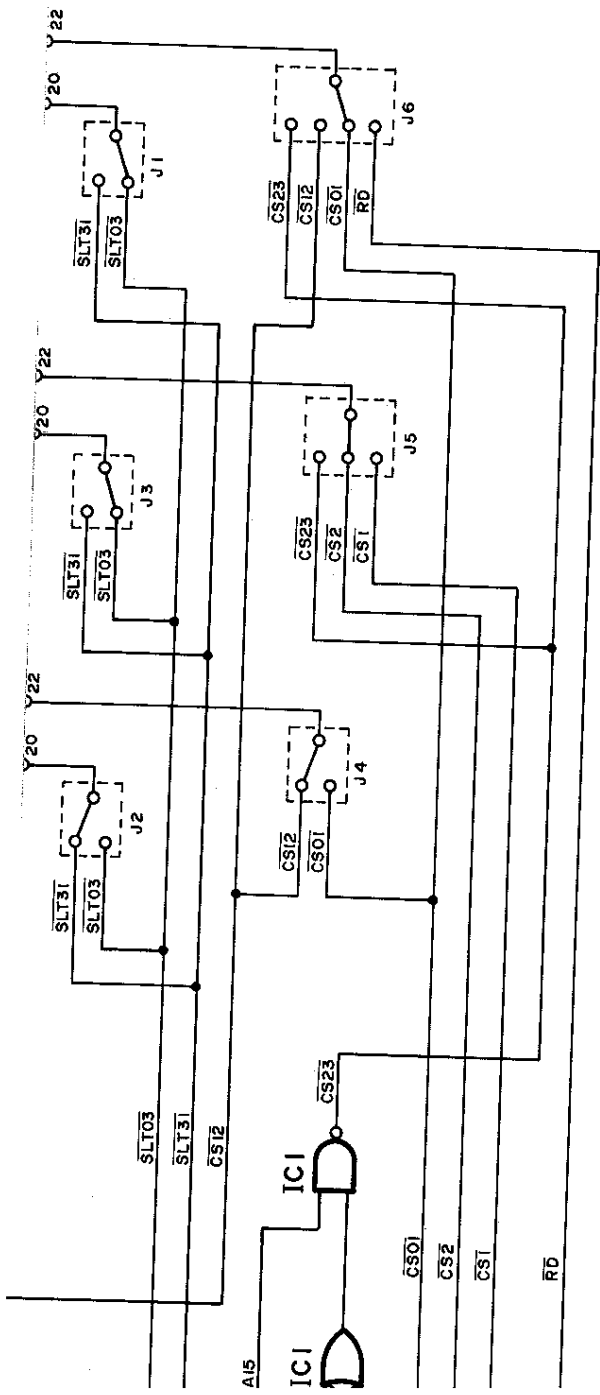
VIDEO UNIT CIRCU

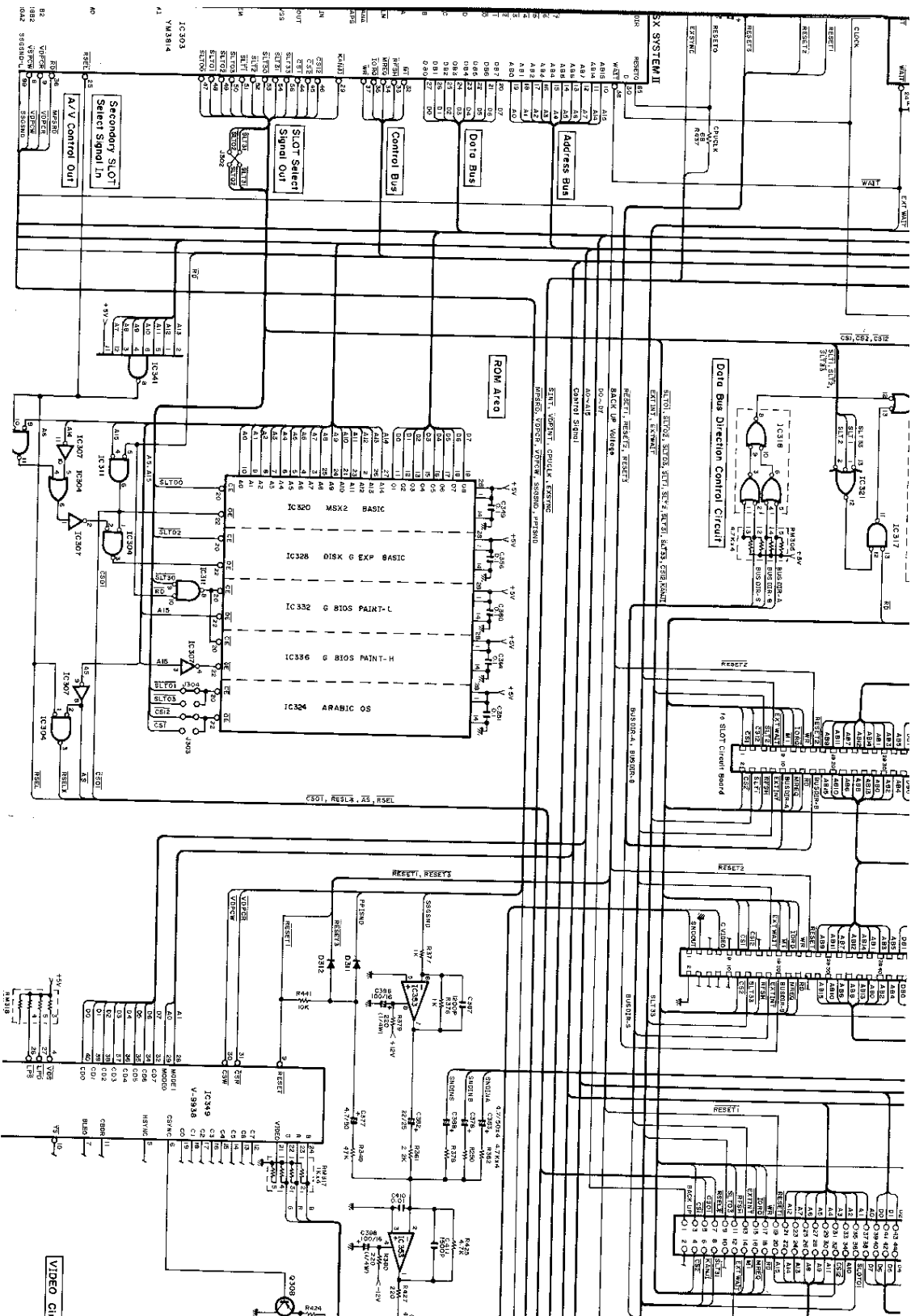


SLOT CIRCUIT BO









IC303
MSX2 BASIC

IC304
V-S838

IC307
V-S839

IC328
MSX2 BASIC

IC328
DISK G EXP BASIC

IC332
G BIOS PAINT-L

IC336
G BIOS PAINT-H

IC344
ARABIC OS

IC349
V-S838

IC350
V-S839

IC304
V-S838

IC304
V-S838

IC304
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